LBI-4622B



Mobile Communications

MASTR II MAINTENANCE MANUAL 406-420 & 512 MHz, 40-WATT TRANSMITTER



Ericsson GE Mobile Communications Inc. Mountain View Road • Lynchburg, Virginia 24502

Maintenance Manual

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SPECIFICATIONS *

Power Output	(0 M)
406-420 MHz & 450-470 MHz	40 Wa
470-494 MHz	38 Wa
494-512 MHz	35 Wa
Crystal Multiplication Factor	36
Frequency Stability	
5C-ICOM with EC-ICOM	± 0.000
5C-ICOM or EC-ICOM	± 0.000
2C-ICOMS	±0.000
Spurious and Harmonic Emission	At lea
Modulation	Adjus
	modul
Modulation Sensitivity	75 to 1
Audio Frequency Characteristics	Within
	300 to
	and E
Distortion	Less t
	Less t
Deviation Symmetry	0.5 kH
Maximum Frequency Spread (2 to 8 channels)	Full S
406-420 MHz	2
450-470 MHz	2
470-494 MHz	2
494-512 MHz	3.
Duty Cuels	
Duty Cycle	EIA 2
RF Output Impedance	50 Oh
* These specifications are intended primarily for the u complete specifications.	use of the service

WARNING

may be drawn under short circuit conditions. These currents can possibly heat metal objects such as tools, rings, watchbands, etc., enough to cause burns. Be careful when working near energized circuits! High-level RF energy in the transmitter Power Amplifier assembly can cause RF burns upon contact. KEEP AWAY FROM THESE CIR-CUITS WHEN THE TRANSMITTER IS ENERGIZED!

LBI-4622

- Vatts (Adjustable from 12 to 40 Watts) Vatts (Adjustable from 12 to 38 Watts) Vatts (Adjustable from 12 to 35 Watts)
- 005% (-40°C to +70°C) $002\% (0^{\circ}C \text{ to } +55^{\circ}C)$ 002% (-40°C to +70°C)
- east 80 dB below full rated power output.
- stable from 0 to \pm 5 kHz swing with instantaneous ulation limiting.
- o 120 Millivolts
- in +1 dB to -3 dB of a 6-dB/octave pre-emphasis from to 3000 Hz per EIA standards. Post limiter filter per FCC EIA.
- than 2% (1000 Hz) than 3% (300 to 3000 Hz)
- KHz maximum
- Specifications 1 dB Degradation 6.00 MHz 2.75 MHz 9.00 MHz 2.75 MHz 2.90 MHz 9.50 MHz 3.00 MHz 9.75 MHz
- 20% Intermittent
- 0hms
- ceman. Refer to the appropriate Specification Sheet for the

Although the highest DC voltage in MASTR II Mobile Equipment is supplied by the vehicle battery, high currents

DESCRIPTION

MASTR II transmitters are crystal controlled, phase modulated transmitters designed for one through eight-frequency operation in the 406 to 420 and 450 to 512 megahertz band. The solid state transmitter utilizes both integrated circuits (ICs) and discrete components, and consists of the following assemblies:

Exciter Board; with audio, modulator, amplifier and multiplier stages

Power Amplifier Assembly; with amplifier, driver, PA, power control, filter and antenna switch.

CIRCUIT ANALYSIS

EXCITER

The exciter uses seven transistors and one integrated circuit to drive the PA assembly. The exciter can be equipped with up to eight Integrated Circuit Oscillator Modules (ICOMs). The ICOM crystal frequency ranges from approximately 11.3 to 14.2 megahertz, and the crystal frequency is multiplied 36 times.

Audio, supply voltages and control functions are connected from the system board to the exciter board through P902.

Centralized metering jack J103 is provided fro use with GE Test Set Model 4EX3A11 or Test Kit 4EX8K12. The test set meters the modulator, multiplier and amplifier stages. and the regulated 10-Volts.

ICOMS

Three different types of ICOMs are available for use in the exciter. Each of the ICOMs contains a crystal-controlled Colpitts oscillator, and two of the ICOMs contain compensator ICs. The different ICOMs are:

5C-ICOM - contains an oscillator and a 5 part-per-million (±0.0005%) compensator IC, Provides compensation for EC-ICOMs.

EC-ICOM - contains an oscillator only. Requires external compensation from a 5C-ICOM.

2C-ICOM - contains an oscillator only. 2 PPM (±0.0002%) compensator IC. Will not provide compensation for an EC-ICOM.

The ICOMs are enclosed in an RF shielded can with the type ICOM (5C-ICOM, EC-ICOM or 2C-ICOM) printed on the top of the can. Access to the oscillator trimmer is obtained by prying up the plastic tab on the top of the can. The tabs can also be used to pull the ICOMs out of the radio.

Frequency selection is accomplished by switching the ICOM keying lead (terminal 6) to A- by means of the fre-

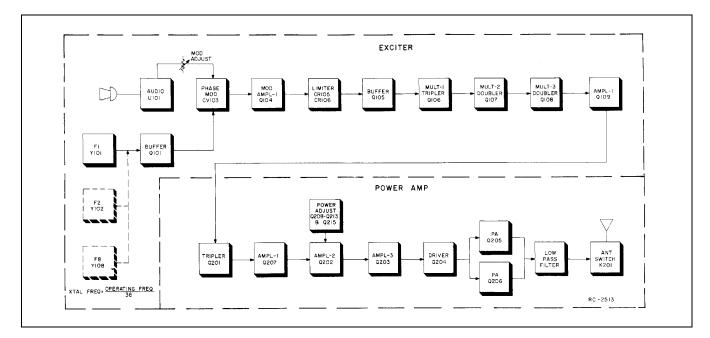


Figure 1 - Transmitter Block Diagram

quency select or switch on the control unit. In single-frequency radios, a jumper from H9 to H10 in the control unit connects terminal 6 of the ICOM to A-. The oscillator is turned on by applying a keyed +10 Volts to the external oscillator load resistor.



All ICOMs are individually compensated at the factory and cannot be repaired in the field. Any attempt to repair or change an ICOM frequency will void the warranty.

> compensation voltage is applied to a varactor (voltage-variable capacitor)which is in parallel with the crystal.

 $(+32^{\circ}F \text{ to } 131^{\circ}F).$

Z

Compensator Circuits

Both the SC-ICOMs and 2C-ICOMs are temperature compensated at both ends of the temperature range to provide instant frequency compensation. An equivalent ICOM circuit is shown in Figure 3.

The cold end compensation circuit does not operate at temperatures above 0°C. When the temperature drops below 0°C, the circuit is activated. As the temperature decreases, the equivalent resistance decreases and the compensation voltage increases.

The increase in compensation voltage decreases the capacity of the varactor in the oscillator, increasing the output frequency of the ICOM.

The hot end compensation circuit does not operate at temperatures below +55°C. When the temperature rises above +55°C, the circuit is activated, As the temperature increases, the equivalent resistance decreases and the compensation voltage decreases. The decrease in compensation voltage increases the capacity of the varactor, decreasing the output frequency of the ICOM.

SERVICE NOTE: Proper ICOM operation is dependent on the closely-controlled input voltages from the 10-Volt regulator. Should all of the ICOMs shift off frequency, check the 10-Volt regulator module.

In Standard 5 PPM radios using EX-ICOMs, at least one 5C-ICOM must be used. The 5C-ICOM is normally used in the receiver Fl position, but can be used in any transmit or receive position. One 5C-ICOM can provide compensation for up to 15 EC-ICOMs in the transmit and receiver. Should the 5C-ICOM compensator fail in the open mode, the EC-ICOMs will still maintain 2 PPM frequency stability from 0°C to 55°C (+32°F to 131°F) due to the regulated compensation voltage (5 Volts) from the 10-Volt regulator IC. If desired, up to 16 SC-ICOMs may be used in the radio.

The 2C-ICOMs are self-compensated at 2 PPM and will not provide compensation for EC-ICOMs.

Oscillator Circuit

The quartz crystals used in ICOMs exhibit the traditional "S" curve characteristics of output frequency versus operating temperature.

At both the coldest and hottest temperatures, the frequency increases with increasing temperature. In the middle temperature range (approximately 0°C to 55°C), frequency decreases with increasing temperature.

Since the rate of change is nearly linear over the mid-temperature range, the output frequency change can be compensated by choosing a parallel compensation capacitor with a temperature coefficient approximately equal and opposite that of the crystal.

Figure 2 shows the typical performance of an uncompensated crystal as well as the typical performance of a crystal which has been matched with a properly chosen compensation capacitor.

At temperatures above and below the mid-range, additional compensation must he introduced. An externally generated

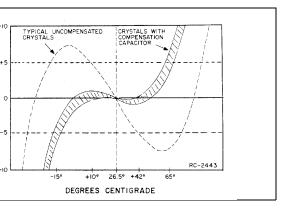


Figure 2 - Typical Crystal Characteristics

A constant bias of 5 Volts (provided from Regulator IC U901 in parallel with the compensator) establishes the varactor capacity at a constant value over the entire mid-temperature range. With no additional compensation, all of the oscillators will provide 2 PPM frequency stability from 0°C to 55°C

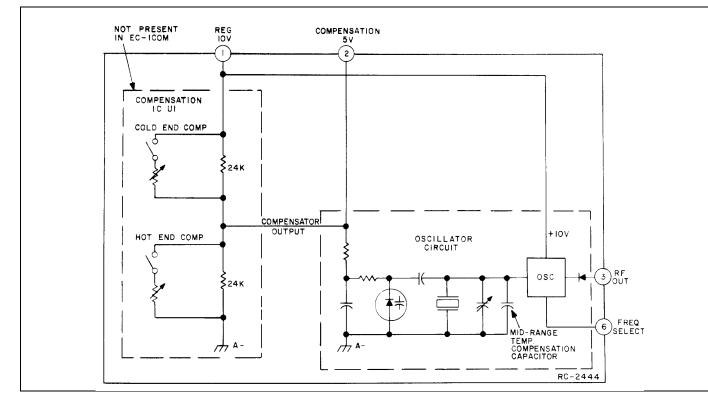


Figure 3 - Equivalent ICOM Circuit

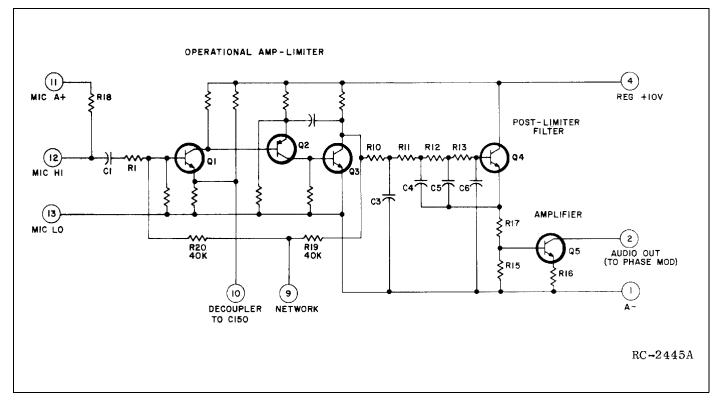


Figure 4 - Simplified Audio IC

Audio IC

The transmitter audio circuitry is contained in audio IC U101. A simplified drawing of the audio IC is shown in Figure 4.

Audio from the microphone at pin 12 is coupled through pre-emphasis capacitor C1 to the base of Q1 in the operational amplifier-limiter circuit. Collector voltage for the transistorized microphone preamplifier is supplied from pin 11 through microphone collector load resistor R18 to pin 12.

The operational amplifier-limiter circuit consists of Q1, Q2 and Q3. Q3 provides limiting at high signal levels. The gain of the operational amplifier circuit is fixed by negative feedback through R19, R20 and the resistance in the network (Pin 9).

The output of Q3 is coupled through a de-emphasis network (R10 and C3) to an active post-limiter filter consisting of C4, C5, C6, R11, R12, R13, R15, R17 and Q4.

Following the post-limiter filter is class A amplifier Q5. The output of Q5 is coupled through MOD ADJUST potentiometer R104 and resistor R125 to the phase modulator.

<u>SERVICE NOTE</u>: If the DC voltages to the Audio IC are correct and no audio output can be obtained, replace U101.

For radios equipped with Channel Guard, tone from the encoder is applied to the phase modulator through CHAN-NEL GUARD MOD ADJUST potentiometer R105, and resistor R127. Instructions for setting R105 are contained in the modulation adjustment section of the Transmitter Alignment Procedure.

Buffer, Phase Modulators & Amplifiers

The output at pin 3 of the selected ICOM is coupled through buffer-amplifier Q101 to the modulator stage. The phase modulator is varactor (voltage-variable capacitor) CV103 in series with tunable coil T103. This network appears as a series-resonant circuit to the RF output of the oscillator. An audio signal applied to the modulator circuit through blocking capacitor C107 varies the bias of CV103. resulting in a phase modulated output. A voltage divider network (R110 and R111) provides the proper bias for varactor CV103.

The output of the modulator is coupled through blocking capacitor C150 to the base of Class A amplifier Q104. The output of the modulator is metered through C123, R128 and CR104, and is applied to the base of buffer Q105. Diodes CR105 and CR106 remove any amplitude modulation in the modulator output.

Buffer Q105 is saturated when no RF signal is present, Applying an RF signal to Q1O5 provides a sawtooth waveform at its collector to drive the class C tripler, Q106. The tripler stage is metered through R138, The output of Q106 is coupled through tuned circuits T104 and T105 to the base of doubler Q107. The doubler stage is metered through R141.

Q109 is a Class C amplifier, and is metered through R148. The amplifier collector circuit consists of T111, C154, C155, T112 and C157, and matches the amplifier output to the input of the power amplifier assembly.

The PA assembly uses seven RF power transistors and seven transistors in the Power Control circuitry to provide rated power output. The broadband PA has no adjustments other than Power Control potentiometer R226.

Supply voltage for the pA is connected through power leads from the system board to feed through capacitors C297 and C298 on the bottom of the PA assembly, C297, C298, C299, L295 and L296 prevent RF from getting on the power leads. Diode CR295 will cause the main fuse in the fuse assembly to blow if the polarity of the power leads is reversed, providing reverse voltage protection for the radio.

The exciter output is coupled through an RF cable to PA input jack J201. The 50-ohm RF input is coupled through a matching network (C206 and w209) to the base of the broadband tripler stage, O201.

Part of the RF input is rectified by CR201 and is used to activate the Power Control circuit. Another portion of the rectified RF is applied to J205 for metering the tripler drive.

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Buffer, Multipliers & Amplifier

The output of Q107 is coupled through tuned circuits T106 and T107 to the base of second doubler Q108. Q108 is metered through R146

The output of Q108 is coupled through three tuned circuits (T108, T109 and T110) to the base of amplifier Q109.

POWER AMPLIFIER

Centralized metering jack J205 is provided for use with GE Test Set Model 4EX3A11 or Test Kit 4EX8K12. The Test Set meters the Tripler drive (exciter output), Amp1-2 input, Driver and PA current.

TRIPLER & RF AMPLIFIERS

The output of Q201 is coup led through a 20-ohm collector matching network (C212, C213, C4219 and L203) to the input of a high-pass filter consisting of C217 through C225. and w210 through w213.

Following the high-pass filter is a low-pass filter consisting of w214 through w219, C226 through C230 (and C4214 through C4217 in the 406-420 MHz band). The two filter sections combine to act as a bandpass filter providing a minimum of 60 dB rejection below 300 megahertz and 30 dB rejection above 600 megahertz.

In 450 to 512 megahertz transmitters, the filter output is coupled through a matching network (C231, C232, C233 and w220) to the base of Class C amplifier Q207. Collector voltage to Q207 is coupled through collector stabilizing network L220, R216 L219 and C234. The output of Q207 is coupled through a matching network (w221, C236, C237 and w222) to the base of the second Class C amplifier Q202. Drive to Q202 is metered at J205 (Amp1-2 Input) through metering network C238, CR202, C239 and R205.

In 406 to 420 megahertz transmitters, Q207 and its associated circuitry is removed, and the filter output is coupled through C285 to the base of second amplifier Q202,

Collector voltage for Q202 is coupled through stabilizing network L206, R206, L205 and C240. Matching network w223,C241, C242, C243 and W224 matches the output of Q202 to the base of third amplifier Q203.

Collector voltage for Q203 is applied through stabilizing network R207, L209, and C246.

The output of Q203 is coupled through a matching network (w225, C247, C248, C249 and w226) to the base of Class C driver Q204. Collector voltage for Q204 is applied through collector stabilizing network C201, L211 and C267.

Collector current for Q204 is metered across tapped manganin resistor R214 at J205 (Driver Current). The reading is taken on the one-Volt scale with the High Sensitivity button pressed, and read as 10 amperes full scale.

Following Q204 is a matching network (w227 and C253) that matches the driver output to the 50-ohm impedance of power divider network W228 and R209.

The power amplifier stages consist of two identical paralleled Class C PA circuits (Q205 and Q206). One output of the power divider network is applied to the base of Q205 through matching network W229 and C268

Supply voltage for Q205 is coupled through collector stabilizing network L213, R210, L214 and C255. The output of Q205 is coupled through a matching network (W231

and C258) and added to the output of Q206 in power combiner network R212 and W233. The combined collector current for Q205 and Q206 is metered across tapped manganin resistor R213 at J205 (PA Current). The reading is taken on the one-Volt scale with the High Sensitivity button pressed, and read as 10 amperes full scale.

The PA output is coupled through a low-pass filter to the antenna through antenna switch K201. Capacitors C214. C270 through C4218 provide DC ground isolation for \pm ground operation.



The stud mount RF Power Transistors used in the transmitter contain Bervllium Oxide, a TOXIC Substance. If the ceramic, or other encapsulation is opened, crushed, broken or abraded, the dust may be hazardous if inhaled. Use care in replacing transistors of this type.

POWER CONTROL CIRCUIT

When the transmitter is keyed, rectified RF from CR201 is applied to the base of switch Q208, turning it on. Turning on Q208 turns on voltage regulator Q210, supplying a constant voltage to Power Adjust potentiometer R226.

Q212, Q213 and Q215 operate as an amplifier chain to supply voltage to the collector of Q202 (Amp1-2). The setting of R226 determines the voltage applied to the base of Q212. The higher the voltage at the base of Q212, the harder the amplifiers conduct, supplying more collector voltage to Q202. The lower the voltage at the base of Q212, the less collector voltage is supplied to Q202. Reducing the supply voltage to Q202 reduces the drive to Q203 and Q204, thereby reducing the power output of the PA. The power output can be adjusted by R226 from approximately 12 to 40 Watts.

Temperature protection is provided by Q209, Q211 and thermistor RT201 which is mounted in the PA heatsink. Under normal operating conditions, the circuit is inactive (Q209 is on and Q211 is off). When the heatsink temperature reaches approximately 100°C, the resistance of RT201 decreases. This increases the base voltage applied to Q209, turning it off. Turning off Q209 allows Q211 to turn on, decreasing the voltage at Power Adjust potentiometer R226. This reduces the base voltage to Q212 which causes Q213 and Q215 to conduct less, reducing the collector voltage to Q202 (Amp1-2). This reduces the transmitter output power, keeping the heatsink at a maximum of approximately 100°C.

When the heatsink temperature decreases below 100°C, the temperature control circuit turns off, allowing the normal transmitter power output.

CARRIER CONTROL TIMER

The Carrier Control Timer option shuts off the transmitter on each transmission after a one-minute timing cycle, and alerts the operator that the transmitter is off by means of an alarm tone in the speaker. The transmitter can be turned on again by releasing and rekeying the push-to-talk switch on the microphone.

The timing cycle (transmitter keyed time) is normally set at the factory for a duration of one minute. A potentiometer permits the timing cycle to be adjusted from approximately 15 second to 3 minutes.

MAINTENANCE

DISASSEMBLY

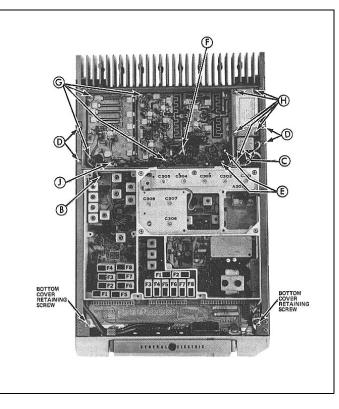
To service the transmitter from the top:

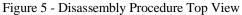
2.

2.

3.

Pull the locking handle down, then pry up the cover at 1. the front notch and lift off the cover.





To service the transmitter from the bottom:

1. Pull the locking handle down and pull the radio out of the mounting frame.

Remove the top cover, then loosen the two bottom cover remaining screws and remove the bottom cover (see Figure 5).

To gain access to the bottom of the exciter board, remove the six screws (\mathbf{A}) holding the exciter board and its bottom cover to the module mounting frame. and remove the bottom cover.

To remove the exciter board from the radio:

1. Unplug the exciter/PA cable (\mathbf{B})

Remove the six screws (\mathbf{A}) holding the exciter board and its bottom cover to the module mounting frame (see Figure 6).

3. Press straight down on the plug-in exciter from the top to avoid bending the pins when unplugging the board from the system board jack.

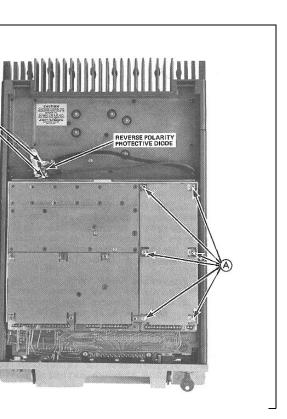


Figure 6 - Disassembly Procedure Bottom View

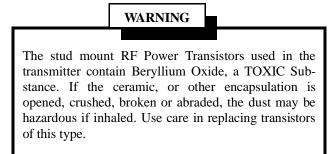
To remove the PA assembly:

- 1. Remove the PA top cover and unplug the exciter/PA cable (\mathbf{B}) , the antenna, receiver and PTT cables (\mathbf{C})
- 2. Remove the four side-rail screws (D), and unsolder the power cables from the bottom of the PA assembly if desired.

To remove the PA board:

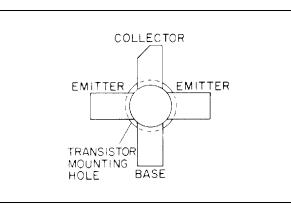
- 1. Remove the PA top cover and unplug the exciter/PA cable (B)
- 2. Unsolder the two feed through coils(E) and the thermistor leads (F)
- 3. Remove the PA transistor hold-down nuts and spring washers on the bottom of the PA assembly.
- Remove the four PA board mounding screws (G), the 4. five screws in the filter casting (H), and the retaining screw in Q215(J), and lift the board out.

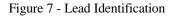
PA TRANSISTOR REPLACEMENT



To replace the PA RF transistors:

- 1. Unsolder one lead at a time with a 50-Watt soldering iron. Use a scribe to hold the lead away from the printed circuit board until the solder cools.
- 2. Turn the transmitter over.
- 3. Hold the body of the transistor to prevent it from turning. Remove the transistor hold-down nut and spring washer through the hole in the heats ink with am 11/32-inch nut-driver. Lift out the transistor, and remove the old solder. from the printed circuit board with a de-soldering tool such as a SOLDA PULLT® Special care should be taken to prevent damage to the printed circuit board runs because part of the matching network is included in the base and collector runs.





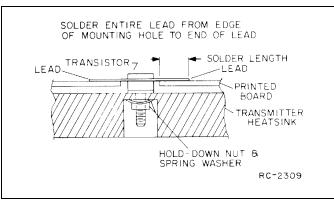
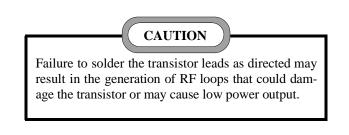


Figure 8 - Lead Forming

- Trim the new transistor leads (if required) to the lead 4 length of the removed transistor. Cut the collector lead at a 45° angle for future identification (see Figure 7). The letter "C" on the top of the transistor also indicates the collector.
- 5. Applying a coating of silicon grease around the transistor mounting surface, and place the transistor in the mounting hole. Align the leads as shown in the Outline Diagram. Then hold the body of the transistor and replace the holding-down nut and spring-washer, using moderate torque (8 inch-pounds). A torque wrench must be used for this adjustment since transistor damage can result if too little or too much torque is used.
- 6. Make sure that the transistor leads are formed as shown in Figure 8 so that the leads can be soldered to the printed circuit pattern, starting from the inner edge of the mounting hole.
- 7. Solder the leads to the printed circuit pattern. Start at the inner edge of mounting hole and solder the remaining length of transistor lead to the board. Use

care not to use excessive heat that causes the printed wire board runs to lift up from the board. Check for shorts and solder bridges before applying power.



MODULATION LEVEL ADJUSTMENT

The MOD ADJUST (R104) was adjusted to the proper setting before shipment and should not normally require readjustment. This setting permits approximately 75% modulation for the average voice level. The audio peaks which would cause overmodulation are clipped by the modulation limiter. The limiter, in conjunction with the de-emphasis network, instantaneously limits the slope of the audio wave to the modulator, thereby preventing overmodulation while preserving intelligibility.

TEST EQUIPMENT

- An audio oscillator (GE Model 4EX6A10) 1.
- A frequency modulation monitor 2.
- 3. An output meter or a VTVM
- GE Test Set Model 4EX3A11 or 4EX8K12 4.

PROCEDURE

- Connect the audio oscillator and the meter across 1. audio input terminals J10 (Green-Hi) and J11 (Black-Lo) on GE Test Set, and connect red Test Set plug to the System red metering plug. If not using GE Test Set, connect audio oscillator and meter across P902-6 (Mike High) through a 0.5 microfarad (or larger) DC blocking capacitor, and P902-5 (Mike-Low) on the System Board
- 2. Adjust the audio oscillator for 1-Volt RMS at 1000 Mz.
- For transmitters without Channel Guard, set MOD 3. ADJUST R104 for a 4.5-kHz swing with the deviation polarity which gives the highest reading as indicated on the frequency modulation monitor.

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- For transmitters with Channel Guard, set Channel 4 Guard MOD ADJUST R105 for zero tone deviation. Next, with the l-Volt signal at 1000 Hz applied, set MOD ADJUST R104 for 3.75 kHz deviation. Then remove the signal from the audio oscillator and set Channel Guard MOD ADJUST R105 for 0.75 kHz tone deviation.
- 5. For multi-frequency transmitters, set the deviation as described in Steps 3 or 4 on the channel producing the largest amount of deviation.

PA POWER INPUT

For FCC purposes, the PA power input can be determined by measuring the PA supply voltage and PA current, and using the following formula:

$$P_i = PA$$
 voltage x PA current

where:

- P_i is the power input in Watts,
- PA voltage is measured with Test Set Model 4EX3A11 in Position G on the 15-Volt range (read as 15 Volts full scale), and with the polarity switch in the (-) position. With Test Set Model 4EX8K12, use the H+ position and the l-Volt range (read as 15 Volts full scale), with the HIGH SENSITIVITY button pressed and the polarity switch in the (-) position.
- PA current is measured with the Test Set in Position G in the Test 1 position, and with the HIGH SENSITIVITY button pressed (10 amperes full scale)
- Example:
- $P_i = 12.6$ Volts x 3.4 amperes = 43 Watts

ICOM FREQUENCY ADJUSTMENT

First, check the frequency to determine if any adjustment is required. The frequency should he set with a frequency meter or counter with an absolute accuracy that is 5 to 10 times better than the tolerance to be maintained, and with the entire radio as near as possible to an ambient temperature of 26.5°C (79.8°F)

MASTR II ICOMs should be reset only when the frequency shows deviation in excess of the following limits:

- A. ± 0.5 PPM, when the radio is at 26.5°C (79.8°F).
- B. ± 2 PPM at any other temperature within the range of -5° C to $+55^{\circ}$ C ($+23^{\circ}$ F to $+131^{\circ}$ F)
- C. The specification limit (± 2 PPM or +5 PPM) at any temperature within the ranges of -40°C to -5°C (- $40^{\circ}F$ to $+23^{\circ}F$) or $+55^{\circ}C$ to $+70^{\circ}C$ (+131°F to +158°F)

If an adjustment is required, pry up the cover on the top of the ICOM to expose the trimmer, and use one of the following procedures

If the radio is at an ambient temperature of 26.5°C (79.8°F), set the oscillator for the correct operating frequency.

If the radio is not at an ambient temperature of 26.5°C setting errors can be minimized as follows:

A. To hold the setting error to ± 0.6 PPM (which is considered reasonable for 5 PPM ICOMS):

- l. Maintain the radio at $26.5^{\circ}C (\pm 5^{\circ}C)$ and set the oscillator to desired frequency, or
- 2. Maintain the radio at 26.5°C (±10°C) and offset the oscillator, as a function of actual temperature, by the amount shown in Figure 9.
- B. To hold setting error to +0.35 PPM (which is considered reasonable for 2 PPM ICOMs) Maintain unit at 26.5°C (+5°C) and offset the oscillator as a function of actual temperature, by the amount shown in Figure 9.

For example: Assume the ambient temperature of the radio is 18.5°C (65.4°F). At that temperature, the curve shows a correction factor of 0.3 PPM. (At 406 MHz, 1 PPM is 406 Hz. At 512 MHz, 1 PPM is 512 Hx).

With an operating frequency of 450 MHz, set the oscillator for a reading of 135 Hz (0.3 x 450 Hz) higher than the licensed operating frequency. If a negative correction factor is obtained (at temperatures above 26.5°C), set the oscillator for the indicated PPM lower than the licensed operating frequency.

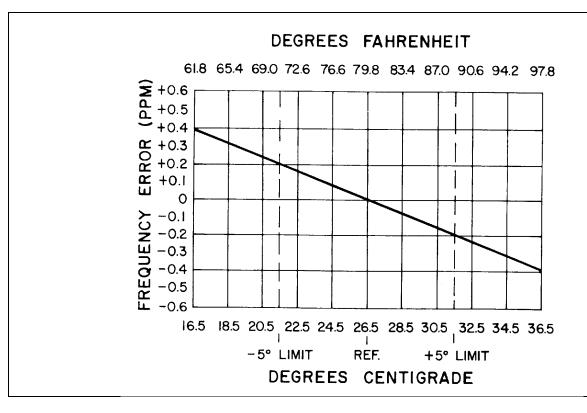
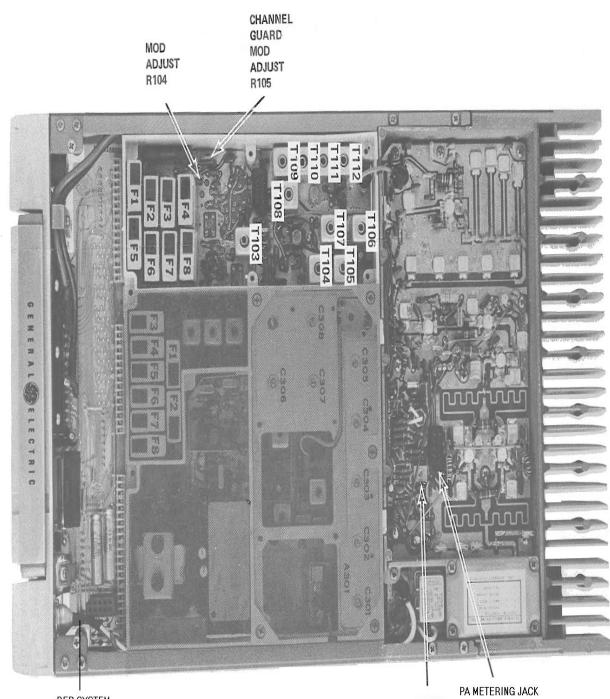


Figure 9 - Frequency Characteristics Vs. Temperature



RED SYSTEM PLUG

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POWER ADJUST R226

TRANSMITTER ALIGNMENT

EQUIPMENT REQUIRED

- 1. GE Test Set Model 4EX3A11 or Test Kit 4EX8K12.
- 2. A 50-ohm wattmeter connected to antenna jack J906.
- 3. A frequency counter.

PRELIMINARY CHECKS AND ADJUSTMENTS

- 1. Place ICOMs on Exciter Board (crystal frequency = operating frequency 36).
- 2. For a large change in frequency or badly mis-aligned transmitter, pre-set the slugs in T104 and T105 to the bottom of the coil form. Pre-set all of the other slugs to the top of the coil form.

NOTE -

The tuning frequency for multi-frequency transmitters is determined by the operating frequency and the frequency spread between transmitters. Refer to the table below for maximum frequency spread.

3. For multi-frequency transmitters with a frequency spread less than that specified in column (1) tune the transmitters to the lowest frequency. For a frequency spread exceeding the limits specified in column (1) tune the transmitters using a center frequency tune up ICOM. Except the maximum frequency spread can be extended to the limits specified in column (3) with 1 dB degradation.

For tuning L101, L102, and L103, always tune L101, L102, and L103 on the lowest frequency.

Multi-frequency Transmitter Tuning

TRANSMITTER FREQUENCY RANGE	MAXIMUM FREQUENCY SPREAD					
	(1) Without center tuning	With center tuning	With center tuning (1 dB degradation)			
406-420 MHz 450-470 MHz 470-494 MHz 494-512 MHz	2.75 MHz 2.75 MHz 2.90 MHz 3.00 MHz	5.50 MHz 5.50 MHz 5.80 MHz 6.00 MHz	6.00 MHz 9.00 MHz 9.50 MHz 9.75 MHz			

4. Connect the red plug on the GE Test Set to the System Board metering jack, and the black plug to the Exciter metering jack. Set the polarity to +, and set the range to the Test 1 position (I-Volt position for 4EXBK12) for all adjustments. NOTE: With the Test Set connected to the PA metering jack, the voltage reading at position "F" with the HIGH SENSI-TIVITY button pressed may be converted to driver collector current by reading the current as 10 amperes full scale. The voltage reading at position "G" with the HIGH SENSITIVITY button pressed may be converted to PA collector current by reading the current as 10 amperes full scale.

5. All adjustments are made with the transmitter keyed. Unkey the transmitter between steps to avoid unnecessary heating.

STEP	METER POSITION	TUNING CONTROL	METER READING
1.	B (MOD-1)	T103	See Procedure
2.	C (MULT-1)	T104	Minimum
3.	D (MULT-2)	T105, T104 & T106	See procedure
4.	F (MULT-3)	T107, T106, T108 & T109	See procedure
5.	G (AMPL-1)	T110, T108	Maximum
6.	D (AMPL-1 DRIVE on pA)	T111 & T112	Maximum
7.	G (AMPL-1)	T108, T109 & T110	Maximum
8.	D (AMPL-1 DRIVE on PA)	T111 & T112	Maximum
9.		R226	
	ADDITION		RANSMITTERS
10.	D (MULT-2)	T105	See procedure
11.	G (AMPL-1)	T110 & T108	Maximum

LBI-4622

PROCEDURE

Tune T103 for the maximum meter reading on the lowest frequency, After tuning T103 for maximum, turn the slug 1/8 of a turn clockwise (increasing inductance).

Tune T104 for a dip in meter reading.

Tune T105 for maximum meter reading and re-adjust T104 for maximum meter reading. Then tune T106 for a dip in meter reading.

Tune T107 for maximum meter reading and re-adjust T106 for maximum meter reading. Then tune T108 for a dip in meter reading and T109 for maximum meter reading.

Tune T110 for maximum meter reading. and then readjust T108 and T109 for maximum meter reading.

Move the black detering plug to the power Amplifier metering jack and tune T111 and then T112 for maximum meter reading. Then alternately tune T111 and T112 for maximum meter reading.

Move the black metering plug hack to the exciter meter ing jack and re-adjust T108, T109 and T110 for maximum meter reading.

Move the black metering plug back to the Power Amplifier metering jack and re-adjust Till and T112 for maximum meter reading.

With tire battery voltage at 13.6 volts or the PA collector voltage at 13.0 volts, set Power Adjust potentiometer R226 on the PA hoard for the desired power output (from 12 to 40 Watts).

If the battery voltage is not at 13.6 volts or the collector voltage at 13.0 volts and full rated outputs desired (40,38 or 35 Watts at 13.6 volts), set R226 for the output power according to tie battery voltage or collector voltage shown in Figures 10, 11 or 12.

– NOTE –

The PA collector voltage is measured as described in the PA POWER INPUT section.

USING CENTER FREQUENCY TUNE-UP ICOM

Move the black metering plug to the exciter metering jack and re-adjust T105 for equal drive on the highest and lowest frequency.

Re-adjust T110 and then T108 for maximum meter reading on the lowest frequency.

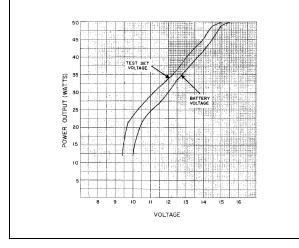


Figure 10 - 40-Watt Power Output Setting Chart

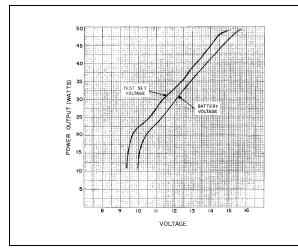


Figure 11 - 38-Watt Power Output Setting Chart

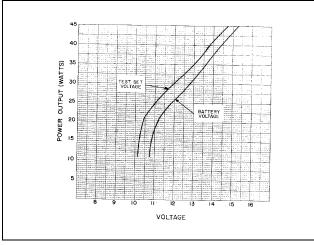


Figure 12 - 35-Watt Power Output Setting Chart

TEST PROCEDURES

These Test Procedures are designed to assist you in servicing a transmitter that is operating -- but not properly. Problems encountered could be low power output, tone and voice deviation, defective audio sensitivity, and modulator adjust control set too high. Once a defect is pin-pointed, refer to the "Service Check" and the additional corrective measures included in the Transmitter Troubleshooting Procedure. Before starting with the Transmitter Test Procedures, be sure the transmitter is tuned and aligned to the proper operating frequency.



Before bench testing the MASTR II Mobile Radio. be sure of the output voltage characteristics of your bench power supply.

To protect the transmitter power output transistors from possible instant destruction, the following input voltages must not be exceeded:

Transmitter unkeyed: 20 Volts Transmitter keyed (50 ohm resistive load): 18 Volts Transmitter keyed (no load or non-resistive load):

15.5 Volts

These voltages are specified at the normal vehicle battery terminals of the radio and take the voltage drop of standard cables into account. The voltage limits shown for a non-optimum load is for "worst case" conditions. For antenna mis- matches likely to be encountered in practice, the actual limit will approach the 18 Volt figure.

Routine transmitter tests should be performed at EIA Standard Test Voltages (13.6 VDC for loads of 6 to 16 amperes: 13.4 VDC for loads of 16 to 36 amperes). Input voltages must not exceed the limits shown, even for transient peaks of short duration.

Many commonly used bench power supplies cannot meet these requirements for load regulation and transient voltage suppression. Bench supplies which employ "brute force" regulation and filtering (such as Lapp Model 73) may be usable when operated in parallel with a 12-Volt automotive storage battery.

TEST EOUIPMENT REOUIRED

for test hookup as shown:

- 1 Wattmeter similar to: Bird # 43 Jones # 711N
- 2. VTVM similar to: Triplett # 850 Heath # IM-21
- 3. Audio Generator similar to: GE Model 4EX6A10
- Deviation Meter (with a .75 kHz scale) similar to: 4. Measurements # 720
- 5. Multimeter similar to: GE TEST SET MODEL 4EX3A11. MODEL 4EX8K12 or 20,000 ohms-per-Volt voltmeter

POWER MEASUREMENT

TEST PROCEDURE

- 1. Connect transmitter output from the antenna jack to the wattmeter through a 50-ohm coaxial cable. Make sure the wattmeter is terminated into a 50-ohm load.
- 2. Key the transmitter and check the wattmeter for the desired power output.

SERVICE CHECK

Check the setting of the Power Adjust Control (R226). 2. Refer to the QUICK CHECKS on the Transmitter Trou-

bleshooting Procedure.

VOICE DEVIATION SYMMETRY AND **AUDIO SENSITIVITY**

TEST PROCEDURE

- Connect the test equipment to the transmitter as 1. shown.
- 2. In radios with Channel Guard, set Channel Guard Mod Adjust R105 for zero tone deviation.
- 3. Set the Audio generator output to 1.0 VOLTS RMS and frequency to 1 kHz.
- 1.

3.

NOTES:

6.

NOTES:

8.

4. Key the transmitter and adjust Deviation Meter to carrier frequency.

5. Deviation leading should be ± 4.5 kHz in radios without Channel Guard, and ± 3.75 kHz in radios with Channel Guard.

If necessary, adjust MOD ADJUST control R104 for the proper deviation on plus (+) or minus (-) deviation, whichever is greater.

MASTR II transmitters are adjusted for 4.5 kHz deviation at the factory. The factory adjustment will prevent the transmitter from deviating more than 5.0 kHz under the worst conditions of frequency, voltage and temperature.

7. If the deviation reading plus (+) or minus (-) differs by more than 0.5 kHz, recheck Steps 1 and 2 as shown in the Transmitter Alignment Chart.

Check Audio Sensitivity by reducing generator output until deviation falls to 3.0 kHz for radios without Channel Guard, or 2.25 kHz for radios with Channel Guard. Voltage should be LESS than 120 millivolts. If not, refer to the Transmitter Troubleshooting Procedure.

TONE DEVIATION WITH CHANNEL **GUARD TEST PROCEDURE**

TEST PROCEDURE

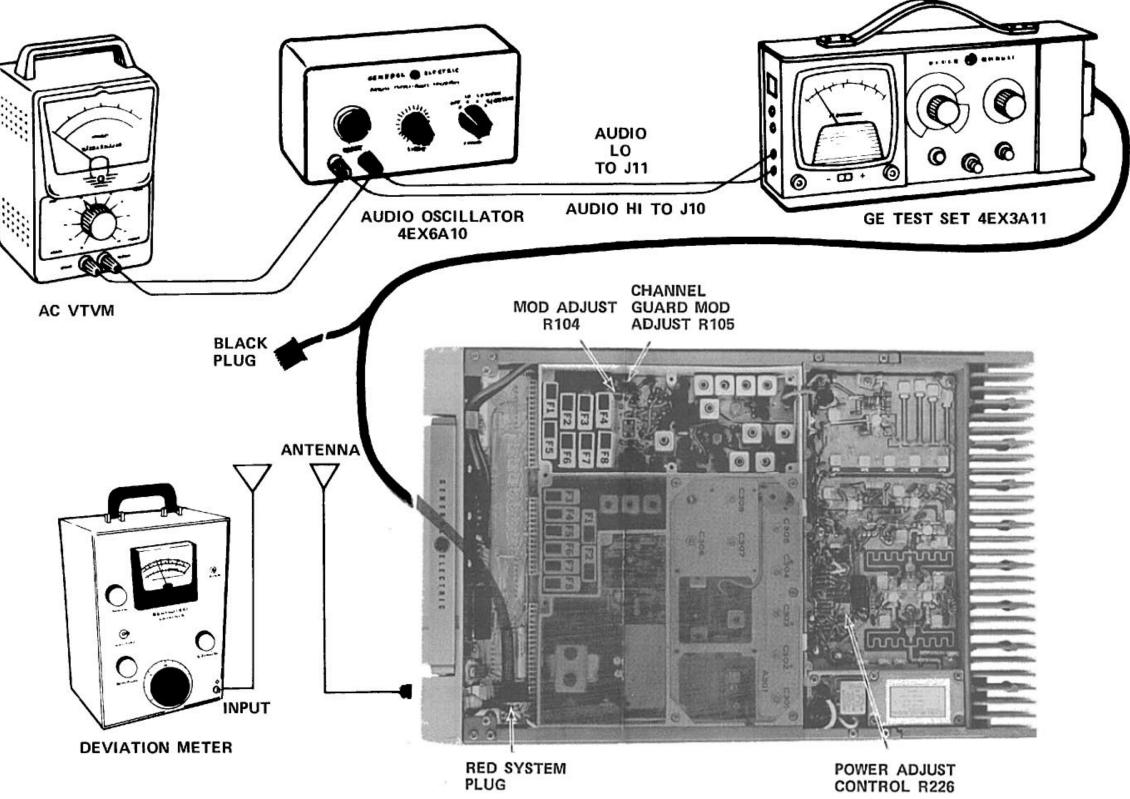
1. Set up the Deviation Meter and monitor the output of the transmitter.

Remove the 1000 Hz signal from the audio generator.

Key the transmitter and check for 0.75 kHz deviation. If the reading is low or high, adjust Channel Guard MOD ADJUST R105 for a reading of 0.75 kHz.

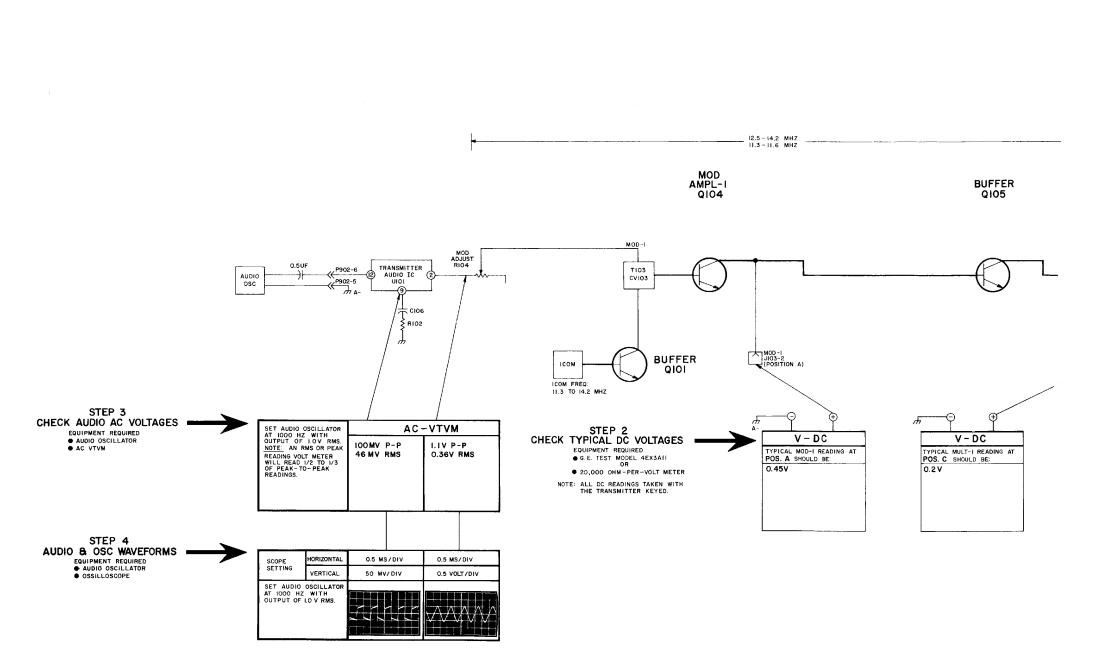
On units supplied with Channel Guard, the Phase Modulator Tuning should be adjusted Carefully to insure proper performance. (Refer to Step 1 in the Transmitter Alignment Chart).

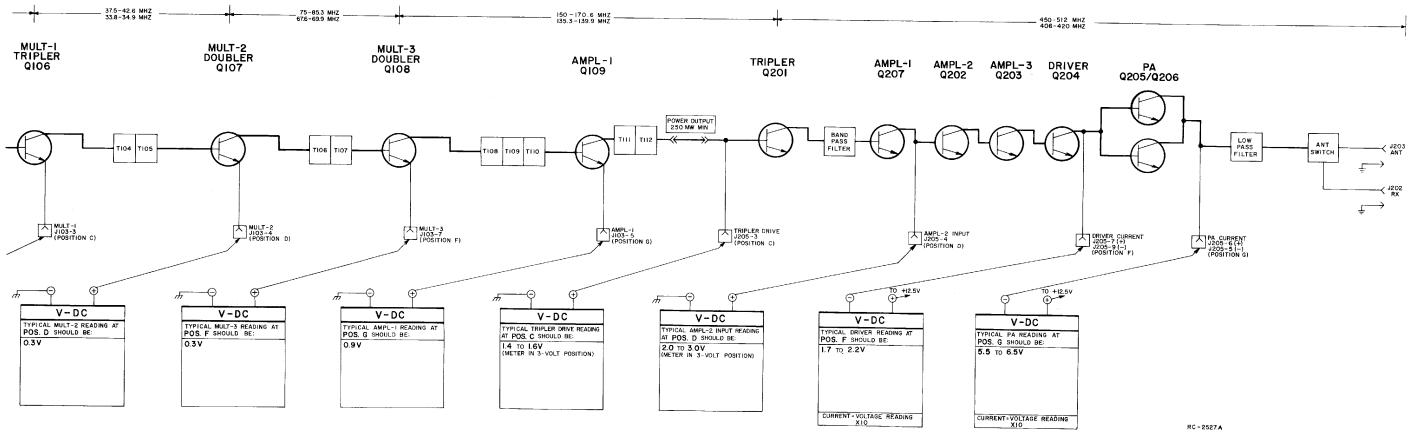
2. The Tone Deviation Test Procedures should be repeated every time the Tone Frequency is changed.



STEP 1 - QUICK CHECKS

METER POSITION GE	PROBA	BLE DEFECTIVE	E STAGE							
TEST SET	HIGH METER READING READING		ZERO METER READING							
	EXCITER									
B (MOD-1)	Q102, 10- Volt Regulator	T103, CV103, C104	T103, CV103, CR104, Q104							
C (MULT-1)	Q105, Q106, T104	Q105, Q106	Q105, Q106, T104							
D (MULT-2)	Q107, T106	T104, T104, Q107	T104, T105, Q107, T106							
F (MULT-3)	Q108, T108	T106, T107, Q108	T106, T107, Q108, T108							
G (AMPL-1)	Q109, C157	T108, T109, T110, Q109	T108, T109, T110, Q109, L106							
	POWER AM	IPLIFIER								
"C" (TRIPLER DRIVE)		Low Output from Exciter	No output from Exciter CR201							
"D" (AMPL-2 INPUT)	Q207	Q207	Q207, Q201							
"F" (DRIVER CURRENT)	Q204	Q204, Low Output from Q201, Q207, Q202, Q203	Q203, Q202, Q207, Q201. Check Pos. C & D							
"G" (PA CURRENT)	Q205, Q206	Q201, Q207, Q202, Q203, Q204, Q205, Q206	Q206, Q205, Q204, Q203, Q202, Q207, Q201, Q215							





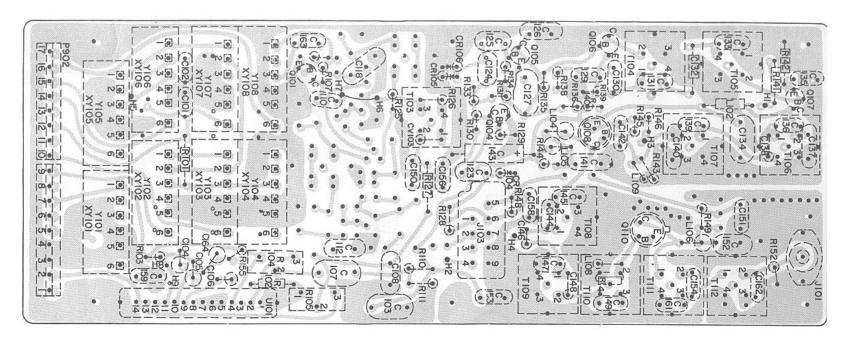
406-512 MHz, 40-WATT TRANSMITTER

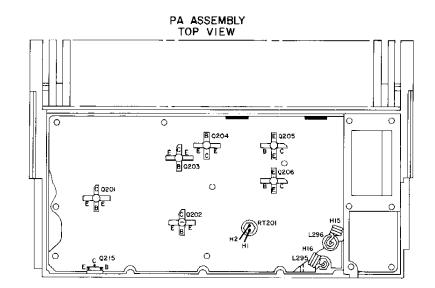
Issue 2

OUTLINE DIAGRAM

EXCITER BOARD

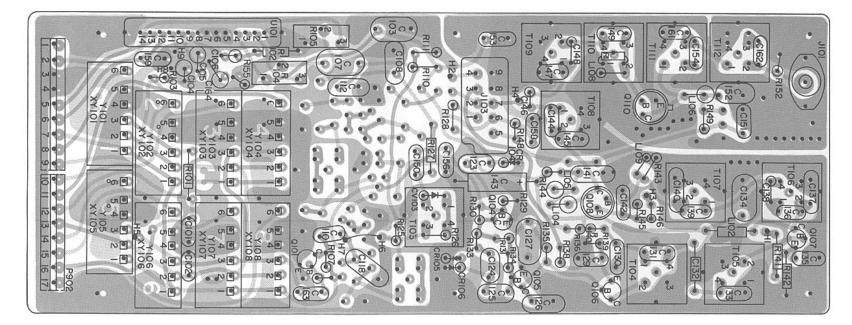
SOLDER SIDE

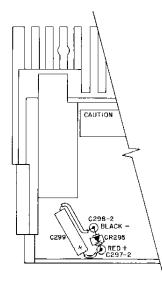




(19D416850, Sh. 2, Rev. 3)

COMPONENT SIDE





(19R622078, Rev. 7)

(19D416850, Sh. 2, Rev. 3) (19D416850, Sh. 3, Rev. 3)

406-512 MHz, 40-WATT TRANSMITTER

LBI-4622

LEAD IDENTIFICATION FOR QIOI-QIO9, Q208, Q212, Q213

N-LINE TRIANGULAR

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION

LEAD IDENTIFICATION FOR 0207,0209,0210,0211

N-LINE TRIANGULAR

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

- RUNS ON SOLDER SIDE

- RUNS ON BOTH SIDES

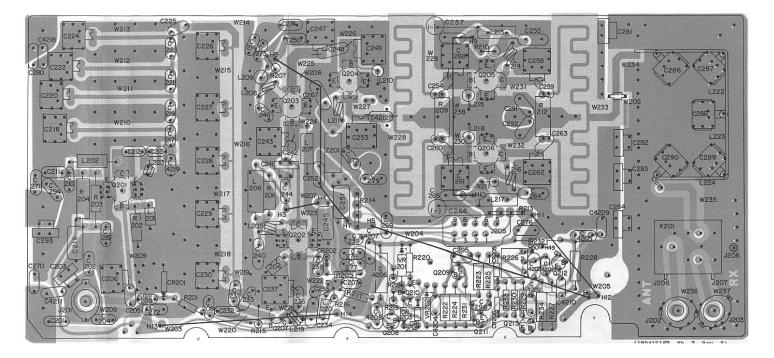
10 4 -

RUNS ON COMPONENT SIDE

OUTLINE DIAGRAM

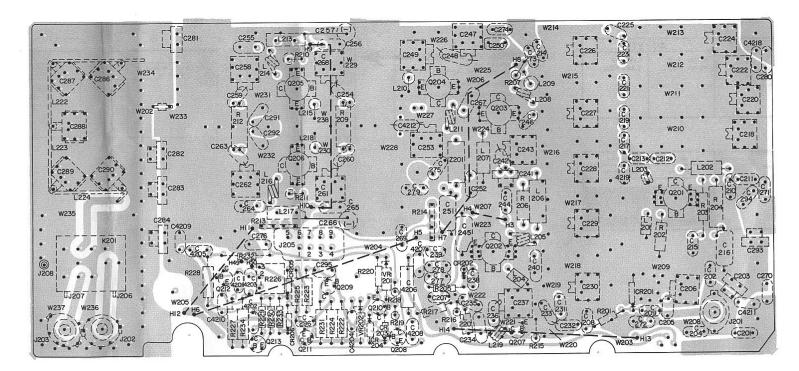
PA BOARD

COMPONENT SIDE



(19D417162, Sh. 2, Rev. 3) (19D417162, Sh. 3, Rev. 5)

SOLDER SIDE



(19D417162, Sh. 2, Rev. 3)

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

- REV. A <u>Exciter Board 19D416859G5, G7</u>, To improve operation. Deleted Cl36L. Changed Cl36H, Cl37, Cl44L, Cl45, Cl46, CV103. Added Cl37L, Cl45L, Cl46L, CV103L, Ll08, Rl52 and Rl53.
- REV. B To improve drive to modulator. Changed Q101 and R106.
 REV. C To increase power output and decrease transmitter noise. Changed Q109, R149 and C109. Deleted R153, C155L and C157L. Added C16LL and CL62L.
- REV. D To improve modulator limiting. Deleted Cl09 and added Cl63.
- REV. E To improve operation. Changed CV101, CV102, CV103, C159 and R105.
- REV. F To reduce alternator noise and to improve operation. Changed R107 and Added R155, R154 and C164.
- REV. G To increase audio sensitivity. Changed R102.
- REV. A $\frac{Exciter\ Board\ 19D416859G6,\ G8}{Changed\ Q101\ and\ R106}$. To improve drive to modulator.
- REV. B To increase power output and reduce transmitter noise. Changed Q109, R149, and C109. Deleted C155H and C157H. Added C161H and C162H.
- REV. C To improve modulator limiting. Deleted C109 and added C163.
- REV. D To improve operation. Changed CV101, CV102, CV103, C159 and R105.
- REV. E To reduce alternator noise and improve operation. Changed R107 and added R154, R155 and C164.
- REV. F To increase audio sensitivity. Changed R102.

PARTS LIST

LBI-4609C

406-420 MHz, 450-512 MHz EXCITER BOARD 19D416859G5-G8

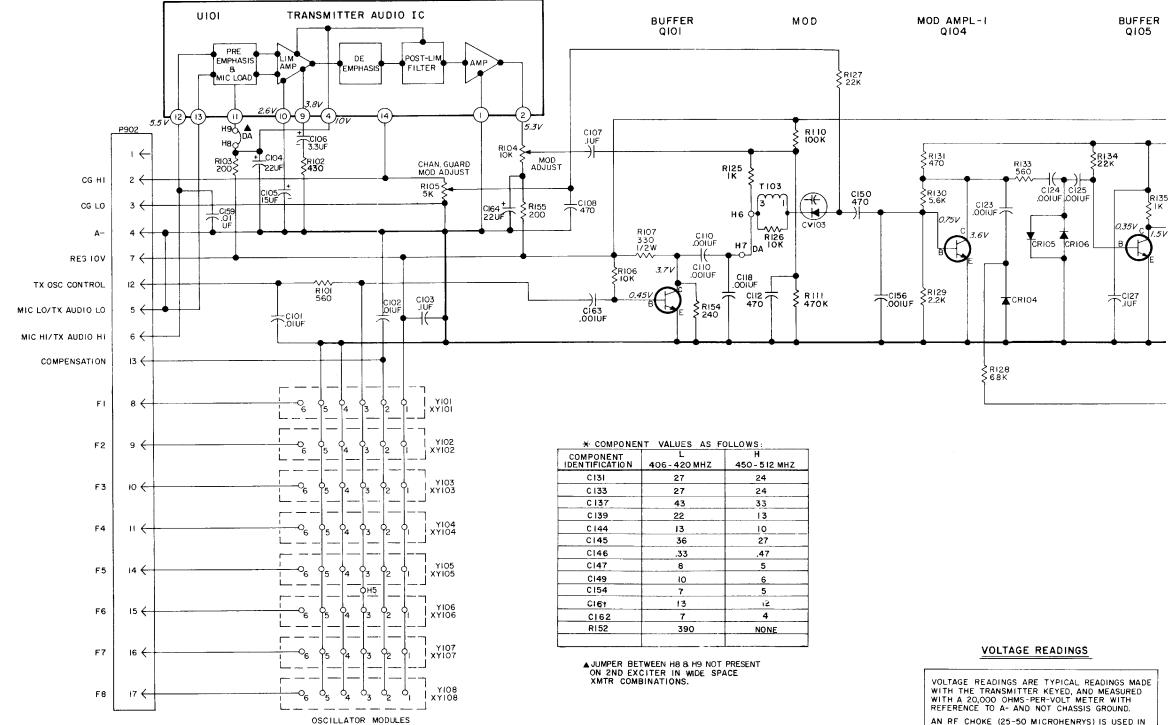
SYMBOL	GE PART NO.	DESCRIPTION
		19D416859G5 2 FREQ 406~420 MHz (L)
		19D416859G6 2 FREQ 450-512 MHz (H) 19D416859G7 8 FREQ 406-420 MHz (L) 19D416859G8 8 FREQ 450-512 MHz (H)
		CAPACITORS
C101 and C102	19A116080P1	Polyester: 0.01 μ f $\pm 20\%$, 50 VDCW.
C103	19A116080P107	Polyester: 0.1 μ f ±10%, 50 VDCW.
C104	5496267P10	Tantalum: 22 μ f ±20%, 15 VDCW; sim to Sprague Type 150D.
C105	5496267P14	Tantalum: 15 μ f \pm 20%, 20 VDCW; sim to Sprague Type 150D.
C106	5496267P9	Tantalum: 3.3 μf ±20%, 15 VDCW; sim to Sprague Type 150D.
C107	19A116080P107	Polyester: 0.1 μ f ±10%, 50 VDCW.
C108	5494481P107	Ceramic disc: 470 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.
C109*	19A116080P107	Polyester: 0.1 μf ±10%, 50 VDCW. Deleted in G5, G7 by REV D; G6, G8 by REV C.
		In G5, G7 of REV B and earlier: In G6, G8 of REV A and earlier:
	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.
C110	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C112	5494481P107	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C118	5494481P112	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C123 thru C125	5494481P111	Ceramic disc: 1000 pf $\pm 20\%,$ 1000 VDCW; sim to RMC Type JF Discap.
C126	7489162P27	Silver mica: 100 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.
C127	19A116080P107	Polyester: 10 μ f ±10%, 50 VDCW.
C129 and C130	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.
C131L	5496219P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.
C131H	5496219P248	Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef -80 PPM.
C132	5491601P118	Phenolic: 0.75 pf ±5%, 500 VDCW.
C133L	5496219P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.
C133H	5496219P248	Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef -80 PPM.
C134	19A116080P107	Polyester: 0.1 μ f ±10%, 50 VDCW.
C135	19A116080P105	Polyester: 0.047 μ f ±10%, 50 VDCW.
C136*	5496219 P 246	Ceramic disc: 20 pf ±5%, 500 VDCW, temp coef -80 PPM. Added to G5 and G7 by REV A.
C136L*	5496219P348	Ceramic disc: 24 pf $\pm 5\%$, 500 VDCW, temp coef -150 PPM. Deleted from G5 and G7 by REV A.
С136н*	5496219P246	Ceramic disc: 20 pf ±5%, 500 VDCW, temp coef -80 PPM. Deleted from G5 and G7 by REV A.
C137*	5496219P251	Ceramic disc: 33 pf $\pm 5\%$, 500 VDCW, temp coef -80 PPM. Deleted from G5 and G7 by REV A.
C137L*	5496219P254	Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef -80 PPM. Added to G5 and G7 by REV A.
	1	

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
C137H*	5496219P251	Ceramic disc: 33 pf $\pm 5\%$, 500 VDCW, temp coef -80 PPM. Added to G5 and G7 by REV A.	C161L*	5496219P243	Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef -80 PPM, Added to G5, G7 by REV C.
C138	5491601P115	Phenolic: 0.56 pf ±5%, 500 VDCW.	C161H*	5496219P242	Ceramic disc: 12 pf $\pm 5\%$, 500 VDCW, temp coef -80 PZM. Added to G6, G8 by REV B.
C139L	5496219P247	Ceramic disc: 22 pf $\pm 5\%$, 500 VDCW, temp coef -80 PPM.	C162L*	5496219P238	Ceramic disc: 7.0 pf ±0.25 pf, 500 VDCW, temp
С139Н	5496219P243	Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef -80 PPM.	C162H*	5496219P235	coef -80 PPM. Added to G5, G7 by REV C. Ceramic disc: 4.0 pf \pm 0.25 pf, 500 VDCW, temp
C140	5496219P348	Ceramic disc: 24 pf $\pm 5\%$, 500 VDCW, temp coef -150 PPM.	C163*	5494481P111	coef -80 PPM. Added to G6, G8 by REV B. Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to
C141	5490008P127	Silver mica: 100 pf $\pm 10\%,$ 500 VDCW; sim to Electro Motive Type DM-15.			RMC Type JF Discap. Added to G5, G7 by REV D. Added to G6, G8 by REV C.
C142	7489162P25	Silver mica: 82 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.	C164*	5496267P10	Tantalum: 22 μ f ±20%, 15 VDC%; sim to Sprague Type 150D.
C143	5496267P10	Tantalum: 22 μf $\pm 20\%,$ 15 VDCW; sim to Sprague Type 150D.			Added to C5, G7 by REV F. Added to G6, G8 by REV E.
C144L*	5496219P243	Ceramic disc: 13 pf ±15%, 500 VDCW, temp coef -80 PPM.			DIODES AND RECTIFIERS
		In G5 and G7 earlier than REV A:	CR104 thru	19A115250P1	Silicon.
	5496219P244	Ceramic disc: 15 pf $\pm 15\%,$ 500 VDCW, temp coef -80 PPM.	CR106 CV103*	5495769P9	Silicon, capacitive: 33 pf ±20%, at 4 VDC.
C144H	5496219 P24 1	Ceramic disc: 10 pf ± 0.25 pf, 500 VDCW, temp coef -80 PPM.			Added to G5 and G7 by REV E. Added to G6 and G8 by REV D.
C145*	5496219P249	Ceramic disc: 27 pf $\pm 5\%$, 500 VDCW, temp coef -80 PPM. Deleted in G5 and G7 by REV A.		5495769P8	Silicon, capacitive: 33 pf ±20%, at 4 VDC. Deleted in G5-G8 by REV A.
C145L*	5496219P252	Ceramic disc: 36 pf ±5%, 500 VDCW, temp coef -80 PPM. Added to G5 and G7 by REV A.	CV103L*	5495769P9	Silicon, capacitive: 33 pf $\pm 20\%$, at 4 VDC. Added to G5, G7 by REV A. Deleted from G5, G7 by REV E.
C145H*	5496219P249	Ceramic disc: 27 pf $\pm 5\%$, 500 VDCW, temp coef -80 PPM. Added to G5 and G7 by REV A.	C¥103H*	5495769P8	Silicon, capacitive: 33 pf ±20%, at 4 VDC. Added to G6, G8 by REV A. Deleted from G6, G8
C146*	5491601P113	Phenolic: 0.47 pf $\pm 5\%$, 500 VDCW. Deleted in G5 and G7 by REV A.			by REV D.
C146L*	5491601P109	Phenolic: 0.33 pf ±5%, 500 VDCW. Added to G5 and G7 by REV A.		10130000401	JACKS AND RECEPTACLES
C146H*	5491601P113	Phenolic: 0.47 pf $\pm 5\%$, 500 VDCW. Added to G5 and G7 by REV A.	J101 J103	19A130924G1 19B219374G1	Receptacle, coaxial: sim to Cinch 14H11613. Connector. Includes:
C147L	5496219P239	Ceramic disc: 8.0 pf ± 0.25 pf, 500 VDCW, temp coef -80 PPM.		19A116651P1	Contacts, (9).
C147H	5496219P236	Ceramic disc: 5.0 pf \pm 0.25 pf, 500 VDCW, temp coef -80 PPM.			INDUCTORS
C148	5491601P111	Phenolic: 0.39 pf ±5%, 500 VDCW.	L102	19B209420P130	Coil, RF: 27.0 μh $\pm 10\%,$ 3.60 ohms DC res max; sim to Jeffers 441316-5.
C149L	5496219P241	Ceramic disc: 10 pf ± 0.25 pf, 500 VDCW, temp coef -80 PPM.	L104	748807997	Choke, RF: 1.50 μh $\pm 10\%,$ 0.50 ohms DC res max; sim to Jeffers 4411-10K.
C149H	5496219P237	Ceramic disc: 6.0 pf ± 0.25 pf, 500 VDCW, temp coef -80 PPM.	L105	7488079P18	Choke, RF: 15.0 μh $\pm 10\%$, 1.20 ohms DC res max; sim to Jeffers 4421-9K.
C150	5496372P365	Ceramic disc: 470 pf $\pm 10\%,$ 500 VDCW, temp coef -4700 PPM.	L106	7488079₽5	Choke, RF: 0.68 μh ±10%, 0.15 ohms DC res max; sim to Jeffers 4411-5K.
C151	19A116655P19	Ceramic disc: 1000 pf $\pm 20\%,$ 1000 VDCW; sim to RMC Type JF Discap.	L108 and	19B209420P123	Coil, RF: 6.80 μh $\pm 10\%,$ 1.80 ohms DC res max; sim to Jeffers 4446-2.
C152	19A116080P107	Polyester: 0.1 μ f ±10%, 50 VDCW.	L109		
C153	19A116655P19	Ceramic disc: 1000 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.	P902		Includes:
C154L	5496219P238	Ceramic disc: 7.0 pf ± 0.25 pf, 500 VDCW, temp coef -80 PPM.		19B219594P2 19B219594P3	Contact strip: 8 pins. Contact strip: 9 pins.
C154H	5496219P236	Ceramic disc: 5.0 pf ± 0.25 pf, 500 VDCW, temp coef -80 PPM.			TRANSISTORS
C155L*	5496219P243	Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef -80 PPM. Deleted in G5, G7 by REV C.	Q101*	19A115330P1	Silicon, NPN.
C155H*	5496219P241	Ceramic disc: 10 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM, Deleted in G6, G8 by REV B.			In G5, G7 of REV A and earlier: In G6, G8 of REV B and earlier:
C156	5494481P112	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	0104	19A115910P1 19A115330P1	Silicon, NPN; sim to Type 2N3904. Silicon, NPN.
C157L*	5496219 P 238	Ceramic disc: 7.0 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM. Deleted in G5, G7 by REV C.	Q104 thru Q106	19/11030091	Sifical, NPR.
C157H*	5496219P236	Ceramic disc: 5.0 pf ± 0.25 pf, 500 VDCW, temp coef -80 PPM. Deleted in G6, G8 by REV H.	Q107	19A115328P1	Silicon, NPN.
C158	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	Q108 Q109*	19A115329P2 19A115329P2	Silicon, NPN. Silicon, NPN. Deleted in G5, G7 by REV C.
C159*	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.			Deleted in G6, G8 by REV B.
		In G5, G7 of REV D and earlier: In G6, G8 of REV C and earlier:	Q110*	19A116868P1	Silicon, NPN; sim to Type 2N4427. Added to G5, G7 by REV C. Added to G6, G8 by REV B.
	19A116655P19	Ceramic disc: 1000 pf $\pm 20\%,$ 1000 VDCW; sim to RMC Type JF Discap.			
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SYMBOL	ge part no.	DESCRIPTION	SYMBOL	ge part no.	DESCRIPTION
			R155*	3R152P201J	Composition: 200 ohms ±5%, 1/4 w.
R101	3R152P561K	Composition: 560 ohms ±10%, 1/4 w.			Added to G5, G7 by REV F. Added to G6, G8 by REV E.
R102*	3R152P431J	Composition: 430 ohms $\pm 5\%$, $1/4$ w.			
		In G5, G7 of REV F and earlier:		10041004001	
		in G6, G8 of REV E and earlier:	т103	19D416843G1	Coil. Includes:
	3R152P391K	Composition: 390 ohms $\pm 10\%$, 1/4 w.		5493185P12	Tuning slug.
R103*	3R152P201J	Composition: 200 ohms ±5%, 1/4 w.	T104	19D416843G3	Coil. Includes:
		In G5, G7 of REV D and carlier: In G6, G8 of REV C and carlier:	m1.05	5493185P12	Tuning slug.
	3R152P102K	Composition: 1000 ohms $\pm 10\%$, 1/4 w.	T105	19D416843G2 5493185P12	Coil. Includes: Tuning slug.
R104	19B209358P106	Variable, carbon film: approx 75 to 10,000 ohms	T106	19D416843G7	Coil, Includes:
R105*	19B209358P105	±10%, 0.25 w; sim to CTS Type X-201. Variable, carbon film: approx 200 to 5000 ohms	and T107	5493185P12	Tuning slug.
		±10%, 0.25 w; sim to CTS Type X-201.	T108	19D416843G5	Coil. Includes:
		In G5, G7 of REV D and earlier: In G6, G8 of REV C and carlier:	and T109	12041004300	corr. merudes.
	19B209358P108	Variable, carbon film: approx 2000 to 50,000 ohms $\pm 10\%$, 0.25 w; sim to CTS Type X-201.	1200	5493185P13	Tuning slug.
R106*	3R152P103K	Composition: 10,000 ohms ±10%, 1/4 w.	т110		COIL ASSEMBLY
W100*	3R132P103K	In G5, G7 of REV A and earlier:			19D416843G8
		In G6, G8 of REV B and earlier:			
	3R152P393K	Composition: 39,000 ohms $\pm 10\%$, 1/4 w.	Rl	3R152P151K	Composition: 150 ohms $\pm 10\%$, $1/4$ w.
R107*	3R77P331K	Composition: 330 ohms $\pm 10\%$, 1/2 w.			
		In G5, G7 of REV E and earlier: In G6, G8 of REV D and earlier:			
	3R152P331K	Composition: 330 ohms ±10%, 1/4 w.		5493185P13	Tuning slug.
R110	3R152P104K	Composition: 0.10 megohm $\pm 10\%$, 1/4 w,	T111	19D416843G4	Coil. Includes:
R111	3R152P474K	Composition: 0.47 megohm $\pm 10\%$, 1/4 w.		5493185P12	Tuning slug.
R125	3R152P102K	Composition: 101000 ohms ±10%, 1/4 w.	T112	19D416843G6	Coil. Includes:
R126	3R152P103K	Composition: 10,000 ohms ±10%, 1/4 w.		5493185P12	Tuning slug.
R127	3R152P223K	Composition: 22,000 ohms $\pm 10\%$, $1/4$ w.			INTEGRATED CIRCUITS
R128	3R152P683K	Composition: 69,000 ohms ±10%, 1/4 w.	U101	19D416542G1	Audio Transmitter.
R129	3R152P222K	Composition: 2200 ohms ±10%, 1/4 w.			SOCKETS
R130	3R152P562K	Composition: 5600 ohms (10%, 1/4 w.	XY101		Socket. Part of Mechanical Construction. Inclu
R131	3R152P471K	Composition: 470 ohms ±10%, 1/4 w.	thru XY108		SUCKEC, Part of mechanical construction. Incl.
R133	3R152P561K	Composition: 560 ohms ±10%, 1/4 w.	ATTOO	19A116779P1	Contact, electrical: sim to Molex 08-54-0404 Quantity (6) with each.
R134	3R152P223K	Composition: 22,000 ohms ±10%, 1/4 w.			
R135	3R152P102K	Composition: 1000 ohms $\pm 10\%$, $1/4$ w.			OSCILLATORS
R136	3R152P470K	Composition: 47 ohms ±10%, 1/4 w.			NOTE: When reordering specify ICOM Frequency
R138	3R152P473K	Composition: 47,000 ohms $\pm 10\%$, 1/4 w.			ICOM Freq = Operating Frequency
R139	3R152P181K	Composition: 180 ohms $\pm 10\%$, $1/4$ w.			36
R140	3R152P271K	Composition: 270 ohms ±10%, 1/4 w.	¥101	19A129393G18	Externally compensated, ±5 PPM, 406-512 MHz.
R141	3R152P103K	Composition: 10,000 ohms ±10%, 1/4 w.	thru Y108		
R142	3R152P620J	Composition: 62 ohms ±5%, 1/4 w.	¥101	19A129393G15	Externally compensated, ± 2 PPM, 406-512 MHz.
R143	3R152P331K	Composition: 330 ohms $\pm 10\%$, $1/4$ w.	thru Y108		
R144	3R152P181K	Composition: 180 ohms ±10%, 1/4 w.			
R145	3R152P390K	Camposition: 39 ohms ±10%, 1/4 w.			MECHANICAL PARTS
R146	3R152P333K	Composition: 33,000 ohms $\pm 10\%$, $1/4$ w.		19A129424G2	Can. (Used with T103-T112).
R148	3R77P100J	Composition: 10 ohms ±5%, 1/2 w.		4036555P1	Insulator, washer: nylon. (Used with Q108,
R149*	3R152P240J	Composition: 24 ohms $\pm 5\%$, $1/2$ w. In G5, G7 of REV B and earlier:			Q110).
		In G6, G8 of REV A and earlier:			
	3R152P100K	Composition: 10 ohms $\pm 10\%$, $1/4$ w.			
R152*	3R152P391K	Composition: 390 ohms $\pm 10\%$, $1/4$ w. Added to G5 and G7 by REV A.			
R153*	3R152P100K	Composition: 10 ohms $\pm 10\%$, $1/4$ w. Added to G5 and G7 by REV A. Deleted in G5, G7 by REV C.			
R154*	3R152P241J	Composition: 240 ohms $\pm 5\%$, 1/4 w. Added to G5, G7 by REV F. Added to G6, G8 by REV E.			

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LBI-4622
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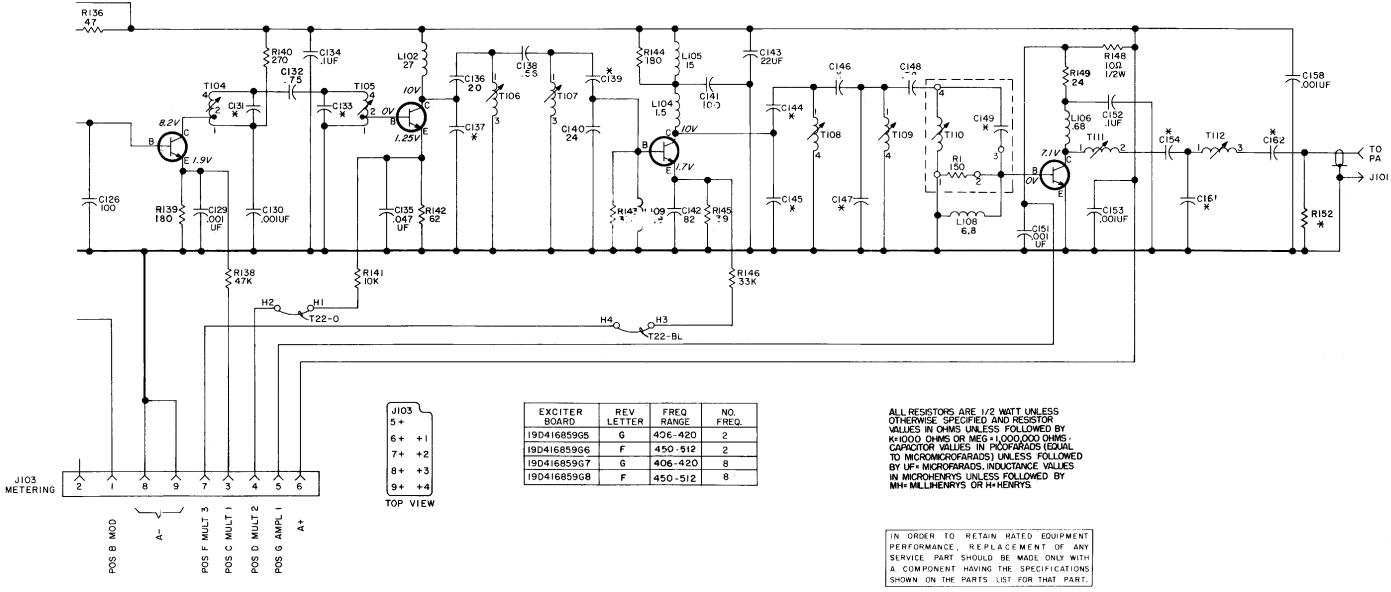
406-512 MHz, EXCITER BOARD 19D416859G5-G8

LBI-4622



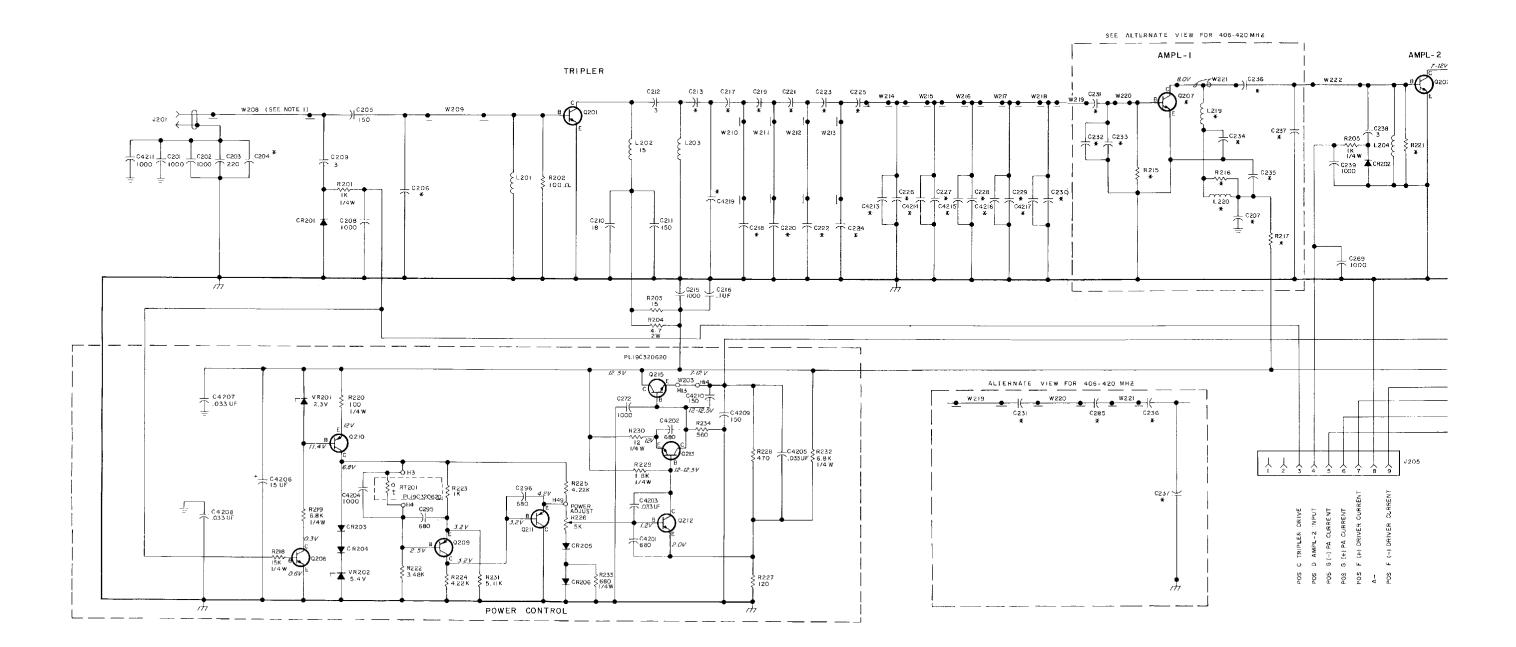
AN RF CHOKE (25-50 MICROHENRYS) IS USED IN THE HOT METER LEAD TO AVOID DETUNING RF CIRCUITS.

(19R622018, Rev. 11)

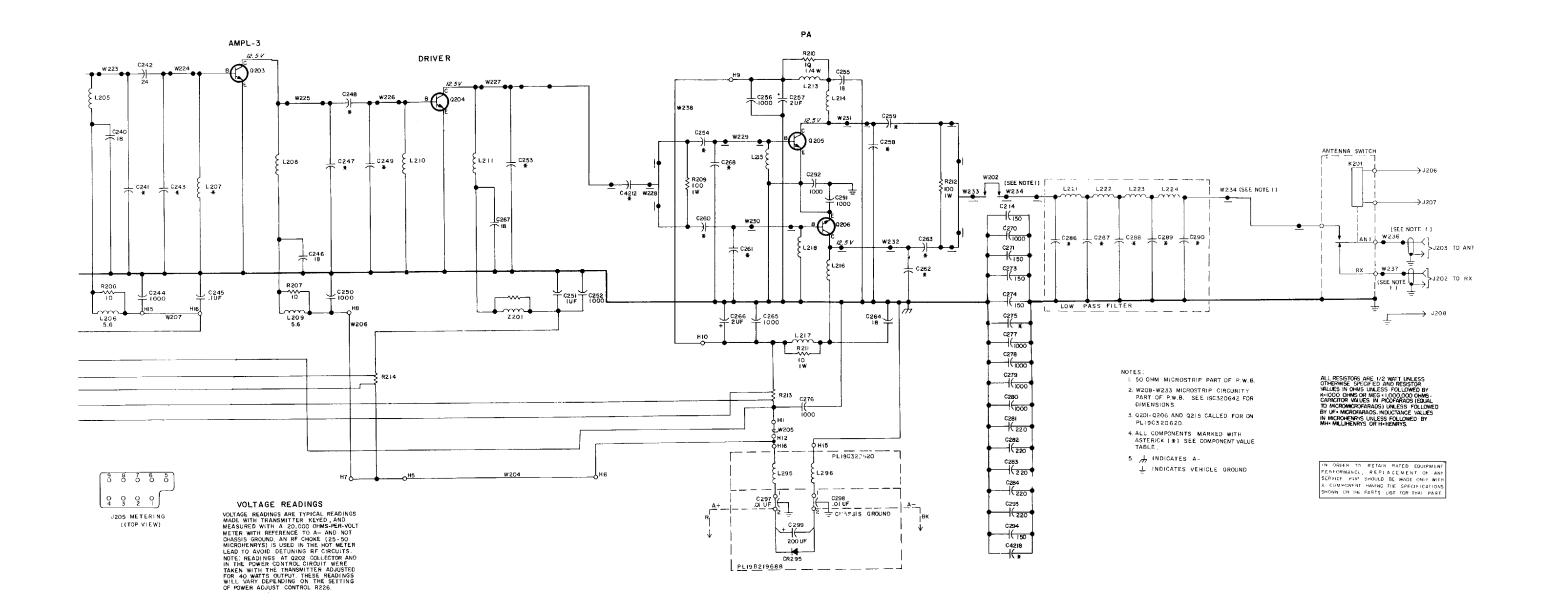


406-512 MHz, EXCITER BOARD

19D416859G5-G8



406-512 MHz, 40-WATT POWER AMPLIFIER 19C320620G5-G8



406-512 MHz, 40-WATT POWER AMPLIFIER 19C320620G5-G8

		PARTS LIST	SYMBOL	ge part no.	DESCRIPTION
		LB1-46198 406-420, 450-512 MHz	C213M	19A116656P3J0	Ceramic disc: 3 pf ±0.5 pf, 500 VDCW, temp
		405-9420, 450-512 MHz 40 WATT POWER MMPLIFIER 19C320620G5-G8	C213H	5491238P12	coef 0 PPM. Ceramic disc: 2 pf ±0.25 pf, 500 VDCW,
			C214		temp coef ±120 PPM.
				19A116655P8	Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
SYMBOL	GE PART NO.	DESCRIPTION	C215	19A116655P20	Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap.
			C216*	19A116966P107	Metallized polyester: .1 μ f ±10%, 50 VDCW. In Gl, G2, G4 earlier than REV A:
L295	19A129562P2	Coil,		5496267P13	In G3 of REV A and earlier: Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague
and L296			C217LL	19A116656P15J0	Туре 150D. Ceramic disc: 15 pf ±5%, 500 УДСЖ, temp
Q201	19A129283P1	Silicon, NPN.	C217L	19A116656P12J0	coef 0 9PM. Ceramic disc: 12 pf ±5%, 500 VDCW, temp
Q202	19A116953P1	Silicon, NPN.	C217M	19A116656P12J0	coef 0 PPM. Ceramic disc: 12 pf ±5%, 500 VDCW, temp
Q203 Q204	19A116953P2 19A129283P4	Silicon, NPN. Silicon, NPN.			coef 0 PPM,
0204 thru Q206			C217H	19A116656P12J0	Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef 0 PPM.
Q215	19A116742P1	Sillcon, NPN.	C218LL	19A116952P25	Silver mica: 25 pf $\pm 2\%$, 250 VDCW; sim to Underwood Type J1HF.
		THERM ISTORS	C218L	19A116952 P 22	Silver mlca: 22 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
RT201	19A129379G1	Thermistor.	C218M	19A116952P22	Silver mica: 22 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
		POWER AMPLIFIER BOARD 19D417166G1 403-430 MHz (LL) 19D417166G2 450-470 MHz (L)	C218H	19A116952P22	Silver mica: 22 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
		19D417166C3 470-494 MHz (M) 19D417166C4 494-512 MHz (H)	C219LL	19A116656P7J0	Ceramic disc: 7 pf ± 0.5 pf, 500 VDCW, temp coef 0 PPM.
			C219L	19A116656P6J0	Ceramic disc: 6 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.
C201 and	19A116655P20	Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap.	C219M	19A116656P6J0	Ceramic disc: 6 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.
C202 C203	19A116679P220K	Mica: 220 pf ±10%, 250 VDCW,	C219H	19A116656P5J0	Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.
C204LL	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C220LL	19A116952P14	Silver mica: 14 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C204L	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C220L	19A116952P12	Silver mica: 12 pf 10.5 pf, 250 VDCW; sim to Underwood Type J1HF,
C204M	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C220M	19A116952P12	Silver mica: 12 pf +0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C204H	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C220H	19A116952Pll	Silver mica: 11 pf ±0.5 pf, 250 VDCW; sim to Underwood Type JHF.
C205	19411665528	Ceramic disc: 150 pf ±10%, 1000 ¥DC¥; sim to NMC Type Jf Discap.	C221LL	19A116656P7J0	Ueramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PDM.
C206LL	19A116952P105	Silver mica: 105 pf ±2%, 250 VIXW; sim to Underwood Type J1HF.	C221L	19A116656P6J0	Ceramic disc: 6 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.
C306F	19A116952P94	Silver mica: 94 pf ±2%, 250 VDCW; sim to Underwood Type JLHF.	C221M	19A116656P6J0	Corramic disc: 6 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.
C206M	19A116952P85	Silver mica: 85 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.	C221H	19A 116656P6J0	Ceramic disc: 6 pf ±0.5 pf, 500 VDCW, temp
С 206Н	19A116952P80	Silver mica: 80 pf ±2%, 250 VDCW; sim to Underwood Type JHF.	C222LL	19A116952P18	coef 0 PPM. Silver mica: 18 pf 10.5 pf, 250 VDCW; sim to
C207	5496218P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.	C2221.	19A116952P16	Underwood Type J1HF. Silver mica: 16 pf ±0.5 pf, 250 VDCW; sim to
C208	19A116655P20	- of FFM. Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C222M	19A116952P16	Underwood Type JlHF. Silver mica: 16 pf ±0.5 pf, 250 VDCW; sim to
C209	19A116656P3J0	Ceramic disc: 3 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM,	C222H	19A116952P15	Underwood Type JIHF. Silver mica: $15 \text{ pf} \pm 0.5 \text{ pf}$, 250 VDCW; sim to
C210	7489162P9	coer 0 PPM. Silver mica: 18 pf ±5%, 500 VDCW; sim to Blectro Motive Type DM-15.	C223LL	19A116656P6J0	Underwood Type J1HF. Ceramic disc: 6 pf ± 0.5 pf, 500 VDCW, temp
C211	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to	C223L	19A116656P5J0	coef 0 PPM. Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp
C212	19A116656P3J0	RMC Type JF Discap. Ceramic disc: 3 pf ±0.5 pf, 500 VDCW, temp	C223M	19A116656P5J0	coef 0 PPM. Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp
C213LL	19A116656P3J0	coef 0 PPM. Ceramic disc: 3 pf ±0.5 pf, 500 VDCW, temp	С223н	19A116656P5J0	coef 0 PPM. Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp
C213L	19A116656P3J0	coef 0 PPM. Ceramic disc: 3 pf ±0.5 pf, 500 VDCW, temp	C224LL	19A116952P105	coef 0 PPM. Silver mica: 105 pf ±2%, 250 VDCW; sim to
		coef 0 PPM.	Cootine.	1941103928103	Underwood Type J]HF.

	PA ASM	REV	HEATSINK ASM	REV LTR	CPNT. BD. ASM	LTR	FREQUENCY
U	19032062005		19821968865		19D417166G1	8	406-420 MHZ
Ť	19032062066		19B219688G5		19D4(7166G2	B	450-470 MHZ
ø	190 32062 0 67		19821968865		190417166G3	Ċ	470-494 MHZ
1s	19032062068		19B21968865		19D417166G4	8	494-512 MHZ
	190320620GI7		198219688GI7		19D 417166G1	В	406 420 MHZ
	190320620GI8		19B2I9688GI7		19D41716662	B	450-470 MHZ
	190320620619		198219688GI7		19D41716663	C.	470-494 MHZ
	190320620620		1982/9688GI7		19041716664	B	494-512 MHZ

COMP	LL 406-420	L 450-470 MH2	М 470-494 МНZ	H 494-512 MHZ
··· · · ·	·····	•		
C206	105	94	85	80
C217	15	12	12	12
C218	25	.22	22	22
C219	7	6	6	5
0220	4	12	12	- Ŭ
C221	7	6	6	6
C2.22	18	16	16	15
0223	6	5	5	5
C224	105	91	9	85
C225	12	9	9	9
C226	5	10	9	9
C227	10	20	19	17
C228	10	20	19	17
C229	10	20	19	17
C230	5	10	9	9
C232	OMIT	8	7	6
C233	OMIT	8	7	6
C237	28	22	t 7	6
C241	13	10	9	8
C243	31	25	20	19
C247	18	15	13	11
C248	27	27	27	27
C249	39	30	28	26
C253	31	23	22	20
C254	680	24	27	27
C258	31	23	23	20
C259	.68C	24	680	660
C260	680	24	27	27
C261	42	30	30	27
C262	31	23	23	20
C263	680	24	680	680
C268	42	30	30	27
C286	11	10	9	9
C287	22	20	17	17
C288	22	20	- 17	7
C289	22	50	- 17	17
C290	1	10	9	9
C4212	150	680	150	680
C42 8	OMIT	OMIT	27	27
C4219	OMIT	OMIT	OMIT	2
0204	1000	1000	1000	150
C275	1000	1000	1000	27
C213	3.	3	3	2
C207	OMIT	27	27	27
C231	24	1000	1000	1000
C234	OMIT	8	18	18
C235	OMIT	1000	1000	1000
C236 C285	24	1000	1000	1000
C4213	6		OMIT	OMIT OMIT
	10			OMIT
C4214	ŧ			
C42I5 C42I6	10	OMIT OMIT	OMIT OMIT	OMIT OMIT
C4216	6	OMIT	OMIT	OMIT OMIT
L207	10	15		15
1.219	OMIT	PRESENT	15 PRESENT	PRESEN
L220	OMIT	PRESENT	PRESENT	PRESEN
0207	OMIT	PRESENT	PRESENT	
R215	OMIT	51	51	51
R216	OMIT	20	20	20
R2(7	OMIT	47	47	47
R221	100	OMIT	OMIT	OMIT
LZIO	15	5.6	15	15
L215	15	5.6	15	15
	15	5.6	15	15

406-512 MHz, 40-WATT POWER AMPLIFIER 19C320620G5-G8

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

SYMBOL	ge part no.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
C224L	19A116952P91	Silver mica: 91 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.	C234	748916229	Silver mica: 18 pf ±5%, 500 YDCW; sim to Electro Motive Type DM-15.	C249M	19A116952P28	Silver mica: 28 pf ±2%, 250 VDCW; sim to
C224M	19A116952P91	Silver mica: 91 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.	C235	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	С249н	19A116952P26	Underwood Type JlHF.
C234H	19A116952P85	Silver mica: 85 pf ±2%, 250 VDCW; sim to	C236LL	19A116656P24J0	Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef			Silver mica: 26 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
C225LL	19A116656P12J0	Underwood Type JlHF. Ceramic disc: 12 pf ±5%, 500 VFJW, temp coef	C236L	19A116655P20	0 PPM. Ceramic disc: 1000 pf ±10%, 1000 VDCW;	C250	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C225L	19A116656P9J0	0 PPM. Ceramic disc: 9 pf ±0.5 pf, 500 VDCW, temp coef	C236M	19A116655P20	sim to RMC Type JF Discap. Ceramic disc: 1000 pf ±10%, 1000 VDCW;	C251*	19A116966P107	Metallized polyester: .1 $\mu f \pm 10\%$, 50 VDCW. In Gl, G2, G4 earlier than REV A:
C225M	19A116656P9J0	O PPM. Ceramic disc: 9 pf ±0.5 pf, 500 VDCW, temp coef	С236Н	19A116655P20	sim to RMC Type JF Discap. Ceramic disc: 1000 pf ±10%, 1000 VDCW;		5496267P13	In G3 of REV A and earlier: Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague
	19A116656P9J0	O PPM. Ceramic disc: 9 pf ±0.5 pf, 500 VDCW, temp coef	C2371L	19A116952P28	sim to RMC Type JF Discap. Silver mica: 28 pf ±23, 250 VDCW; sim to	C252	19A116655P20	Type 150D. Ceramic disc: 1000 pf ±10%, 1000 VDCW:
C225H		0 PPM.			Underwood Type JlHF.	C253LL	19A116952P31	Sim to RMC Type JF Discap. Silver mica: 31 pf ±2%, 250 VDCW; sim to
C226LL	19A116656P5J0	Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.	C237L	19A116952 P 22	Silver mica: 22 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C253L		Underwood Type J1HF.
C226L	19A116952P10	Silver mica: 10 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1NF.	C237M	19A116952P17	Silver mica: 17 pf ±0.5 pf, 250 VDCW; sim to Underwood Type JlHF.		19A116952P23	Silver mtca: 23 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C226M	19A116952P9	Silver mica: 9 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C237H	19A116952P16	Silver mica: 16 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C253M	19A116952P22	Silver mica: 22 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C226H	19A116952P9	Silver mica: 9 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C238	19A116656P3J0	Ceramic disc: 3 pf ± 0.5 pf, 500 VDCW, temp coef 0 PPM.	C253H	19A116952P20	Silver mica: 20 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C227LL	19A116656P10J0	Ceramic disc: 10 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.	C239	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C254LL	19A116655P18	Ceramic disc: 680 pf $\pm 10\%$, 1000 vDCW; sim to RMC Type JF Discap.
C227L	19A116952P20	Silver mica: 20 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C240	7489162P9	Silver mica: 18 pf ±5%, 500 VDCW; sim to Electro Motive Type, DM-15.	C254L	19A116656P24J0	Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef O PPM.
C227M	19A116952P19	Silver mica: 19 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C241LL	19A116679P13D	Mica: 13 pf ±.5 pf, 250 VDCW.	C254M	5496218P249	Ceramic disc: 27 pf $\pm 5\%$, 500 YDCW, temp coef -80 PPM.
C227H	19A116952P17	Silver mica: 17 pf ±0.5 pf, 250 VDCW; sim to	C241L	19A116679P10D	Mica: 10 pf ±,5 pf, 250 VDCW.	C254H	5496218 P 249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.
C228LL	19A116656P10J0	Underwood Type J1HF. Ceramic disc: 10 pf ±0.5 pf, 500 VDCW, temp coef	C241M C241H	19A116679P9D 19A116679P8D	Mica: 9 pf ±.5 pf, 250 VDCW. Mica: 8 pf ±.5 pf, 250 VDCW.	C255	7489162P9	Silver mica: 18 pf 15%, 500 VDCW; sim to Electro Motive Type DM-15.
C228L	19A116952P20	0 PPM. Silver mica: 20 pf ±0.5 pf, 250 VDCW; sim to	C242	19A116656P24J0	Ceramic disc: 24 pf ±5%, 500 YDCW, temp coef 0 PPM.	C256	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C228M	19A116952P19	Underwood Type J1HF. Silver mica: 19 pf ±0.5 pf, 250 VDCW; sim to	C243LL	19A116952P31	Silver mica: 31 pf $\pm 2\%$, 250 VDCW; sim to Underwood Type J1HF.	C257*	19A115680PL	Electrolytic: 2 μf +150% -10%, 25 VDCW; sim to Mallory Type TTX.
		Underwood Type J1HF.	C243L	19A116952P25	Silver mica: 25 pf $\pm 2\%$, 250 VDCW; sim to			In G1, G2, G4 earlier than REV A: In G3 of REV A and earlier;
C228H	19A116952P17	Silver mica: 17 pf ±0.5 pf, 250 VDCW; sim to Underwood Type JlHF.	C243M	19A116952P20	Underwood Type J1HF. Silver mica: 20 pf ±0.5 pf, 250 VDCW; sim to		5496267P13	Tantalum: 2.2 µf ±20%, 20 VLXW; sim to Sprague Type 150D.
C229LL	19A116656P10J0	Ceramic disc: 10 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.	С243Н	19A116952P19	Underwood Type J1HF. Silver mica: 19 pf ±0.5 pf, 250 VDCW; sim to	C25811	19A116952P31	Silver mica: 31 pf +2%, 250 VDCW; sim to
C229L	19A116952P20	Silver mica: 20 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C244	19A116655P20	Underwood Type J1HF. Ceramic disc: 1000 pf ±10%, 1000 VDCW;	C258L	19A116952P23	Underwood Type J1HF. Silver mica: 23 pf ±0.5 pf, 250 VDCW; sim to
C229M	19A116952P19	Silver mica: 19 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C245*	19A116966P107	sim to RMC Type JF Discap. Metallized polyester: .1 µf ±10%, 50 VDCW,	C258M*	19A116952 P 23	Underwood Type J1HF. Silver mica: 23 pf ±0.5 pf, 250 VDCW; sim to
C229H	19A116952P17	Silver mica: 17 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	0245*	1941109005101	In Gl, G2, G4 earlier than REY A:			Underwood Type JlHF. Earlier than REV A:
C230LL	19A116656P5J0	Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.		5496267P13	In G3 of REV A and earlier: Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague		19A116952P22	Silver mica: 22 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C230L	19A116952P10	Silver mica: 10 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type JlHF.	C246	748916229	Type 150D. Silver mica: 18 pf ±5%, 500 VDCW; sim to	C258H	19A116952P20	Silver mica: 20 pf +0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C230M	19A116952P9	Silver mica: 9 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C247LL	19A116952P18	Electro Motive Type DM-15. Silver mica: 18 pf ±2%, 250 VDCW; sim to	C259LL	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCW;
С230Н	19A116952P9	Silver mica: 9 pf ±0.5 pf, 250 VDCW; sim to		19A116952P15	Underwood Type J1HF.	C259L	19A116656P24J0	sim to RMC Type JF Discap. Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef
C231LL	19A116656P24J0	Underwood Type JIHF. Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef	C247L		Silver mica: 15 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.	C259M	19A116655P18	0 PPM. Ceramic disc: 680 pf $\pm 10\%$, 1000 VDCW;
C231L	19A116655P20	0 PPM. Ceramic disc: 1000 pf ±10%, 1000 YDCW;	C247M	19A116952P13	Silver mica: 13 pf $\pm 2\%$, 250 VDCW; sim to Underwood Type J1HF.	C259H	19A116655P18	sim to RMC Type JF Discap. Ceramic disc: 680 pf ±10%, 1000 VDCW;
C231M	19A116655P20	sim to RMC Type JF Discap. Ceramic disc: 1000 pf ±10%, 1000 YDCW;	C247H	19A116952P11	Silver mica: 11 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.	C260LL	19A116655P18	sim to RMC Type JF Discap. Ceramic disc: 680 pf $\pm 10\%$, 1000 YDCW;
C231H	19A116655P20	sim to RMC Type JF Discap. Ceramic disc: 1000 pf ±10%, 1000 VDCW;	C248LL	5496218 P24 9	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.	C260L	19A116656P24J0	sim to RMC Type JF Discap. Ceramic disc: 24 pf +5%, 500 VDCW, temp coef
C232L	19A116656P8J0	Sim to RMC Type JF Discap. Ceramic disc: 8 pf ±0.5 pf, 500 VDCW, temp coef	C248L	5496218P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.	C260M	5496218P249	0 PPM. Ceramic disc: 27 pf ±5%, 500 VDCW, temp
		0 PPM.	C248M	5496218P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.	С260н	5496218P249	coef -80 PPM, Ceramic disc: 27 pf ±5%, 500 VDCW, temp
C232M	19A116656P7J0	Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.	C248H	5496218P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM,	C261LL	19A116952P42	coef -80 PPM.
С232н	19A116656P6J0	Ceramic disc: 6 pf ±0.5 pf, 500 VDCW, temp coef O PPM.	C249LL	19A116952P39	Silver mica: 39 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.			Silver mica: 42 pf ±2%, 250 VDCW; sim to Underwood Type JlHF.
C233L	19A116656P8J0	Ceramic disc: 8 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.	C249L	19A116952P30	Silver mica: 30 pf ±2%, 250 VDCW; sim to Underwood Type JHF.	C261L	19A116952P30	Silver mica: 30 pf ±2%, 250 VDCW; sim to Underwood Type J1HF,
C233N	19A116656P7J0	Ceramic disc: 7 pf ± 0.5 pf, 500 VDCW, temp coef 0 PPM.			onderwood type sint.			
С233н	19A116656P6J0	Caramic disc: 6 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.						

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SYMBOL	ge part no.	DESCRIPTION
C261M	19A116952P30	Silver mica: 30 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
C261H	19A116952P27	Silver mica: 27 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
C262LL	19A116952P31	Silver mica: 31 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
C262L	19A116952P23	Silver mica: 23 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C262M*	19A116952P23	Silver mica: 23 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type JIHF.
	10111000000	Earlier than HEV A:
	19A116952P22	Silver mlca: 22 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C262H	19A116952P20	Silver mlca: 20 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.
C263LL	19A116655P18	Ceramic disc: 680 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap.
C263L	19A116656P24J0	Ceramic disc: 24 pf ±5%, 500 VDCW, temp cocf 0 PPM.
C263M	19A116655P18	Ceramic disc: $680 \text{ pf } \pm 10\%$, 1000 VDCW ; sim to RMC Type JF Discap.
С263Н	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C264	7489162P9	Silver mica: 18 pf ±5%, 500 VDCW; sim to Electro Notive Type DM-15.
C265	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C266+	19A115680P1	Electrolytic: 2 μf +150% -10%, 25 VDCW; sim to Mallory Type TTX.
		In G1, G2, G4 earlier than REV A: In G3 of REV A and earlier:
	5496267P13	Tantalum: 2.2 μf $\pm 20\%,$ 20 VDCW; sim to Sprague Type 150D.
C267	7489162P9	Silver mica: 18 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C268LL	19A116952P42	Silver mica: 42 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
C268L	19A116952P30	Silver mica: 30 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
C268M	19A116952P30	Silver mica: 30 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
C268H	19A116952P27	Silver mica: 27 pf ±2%, 250 VDCW; sim to Underwood Type J1HF.
C269	19A116655P20	Ceramic disc: 1000 pf \pm 10%, 1000 VDCW; sim to RMC Type JF Discap.
C270	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C271	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C272	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C273 and C274	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C275LL	19A116655P20	Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap.
C275L	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 vDCW; sim to RMC Type JF Discap.
C275M	19A116655P20	Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW: sim to RMC Type JF Discap.
C275H	19A116656P27J0	Ceramic disc: 27 pf ±5%, 500 VDCW, temp cocf 0 PPM.
C276 thru C280	19A116655P20	Ceramic disc: 1000 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap.
C281 thru C284	19A116679P220K	Mica: 220 pf ±10%, 250 VDCW.
C285	5496218P45	Cevamic disc: 18 pf ±5%, 530 VDCW, temp coef 0 PPM,
C286LL	19A116952P11	Silver mica: 11 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.

MBOL.	ge part no.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
286L	19A116952P10	Silver mica: 10 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C4213LL	19A116656P6J0	Ceramic disc: 6 pf ±0.5 pf, 500 VDCW, temp coef 0 PDM.
C286M	19A116952P9	Silver mica: 9 pf ±0.5 pf, 250 VDCW; sim to Underwood Type JIHF.	C4214LL	19A116656P10J0	Coramic disc: 10 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.
C286H	19A116952P9	Silver mica: 9 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C4215LL	19A116656P10J0	Ceramic disc: 10 pf ±0.5 pf, 500 VDCW, temp coef O PDM.
C287LL	19A116952P22	Silver mica: 22 pf ±0.5 pf, 250 VDCW; sim to Underwood Type JIHF.	C4216LL	19A116656P10J0	Ceramic disc: 10 pf ± 0.5 pf, 500 VDCW, temp coef 0 PPM.
C287L	19A116952 P 20	Silver mica: 20 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C4217LL	19A116656P6J0	Ceramic disc: 6 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.
C287M	19A116952P17	Silver mica: 17 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C4218M	5496218P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.
C287H	19A116952P17	Silver mica: 17 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C4218H	5496218P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.
C288LL	19A116952P22	Silver mica: 22 pf 10.5 pf, 250 VDCW; sim to Underwood Type J1HF.	C4219H	5491238P12	Ceramic disc: 2 pf ±0.25 pf, 500 VDCW, temp coef -80 ±120 PPM.
C288I,	19A116952P20	Silver mica: 20 pf t0.5 pf, 250 VDCW; sim to Underwood Type J1HF.			DIODES AND RECTIFIERS
288M	19A116952P17	Silver mica: 17 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	CR201*	19A116052P2	Silicon.
C288H	19A116952P17	Silver mica: 17 pf ±0,5 pf, 250 VDCW; sim to Underwood Type J1HF.		10111525021	In G1, G2, G4 of REV A and earlier: In G3 of NEV B and earlier:
289LL	19A116952P22	Silver mica: 22 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	CR202	19A115250P1 19A115250P1	Silicon. Silicon.
289L	19A116952P20	Silver mica: 20 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	thru CR206		
289M	19A116952P17	Silver mica: 17 pf 10.5 pf, 250 VDCW; sim to Underwood Type J1HF.	J201	19A130924G1	JACKS AND RECEPTACLES
C289H	19A116952P17	Silver mica: 17 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.	thru J203		
2901.1,	19A116952P11	Silver mica: 11 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type'J1HF.	J 204 J 208	198219374G1 4033513P4	Connector: 9 contacts. Contact, clectrical: sim to Bead Chain 193-3.
290L	19A116952P10	Silver mica: 10 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.			RELAYS
290M	19A116952 P 9	Silver mica: 9 pf ± 0.5 pf, 250 VDCW; sim to Underwood Type JlHF.	K201	19A116722P1	Hermetic sealed: 125 ohms $\pm 20\%$, 1 form C contact, 9.6 to 15.8 VDC (over the temp range
290н	19A116952P9	Silver mica: 9 pf ±0.5 pf, 250 VDCW; sim to Underwood Type J1HF.			indicated).
2291 and 2292	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L201	19A129773G1	Coil.
293	19A116679P220K	Mica: 220 pf ±10%, 250 VDCW,	L202	7488079 P 18	Choke, RF: 16.0 µh ±10%, 1.20 ohms DC res max; sim to Jeffers 4421-9K.
294	19A116655P8	Coramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L203LL	19A129233P4	Coil.
295 Ind	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	-L203L L203M	19A129233P2 19A129233P3	Coil.
296			L203H	19A129233P3	Coil.
4201 Ind 4202	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L204	19A129773G1	Coll,
4203	19A116080P104	Polyester: 0.033 μ f ±10%, 50 YDCW,	L205	19 B 219457 P 4	Coil.
24204	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L206	7488079940	Chokc, RF: 5.60 μ h \pm 10%, 0.15 ohms DC res max; sim to Jeffers 4422-1K.
4205	19A116080P104	Polyester: 0.033 μf ±10%, 50 ¥DCW.	L207LL	19B209420P125	Coil, RF: 10.0 μh ±10%, 3.10 ohms DC res max; sim to Jeffers 4446-4.
24206	5496267P14	Tantalum: 15 µf ±20%, 20 VDCW; sim to Sprague Type 150D.	L207L	7488079P18	Choke, RF: 15.0 µh ±10%, 1.20 ohms DC rcs max; sim to Jeffers 4421-9.
C4207 and	19A116080P104	Polyestor: 0,033 µf ±10%, 50 VDCW.	L207M	7488079 P 18	Choke, RF: 15.0 μh ±10%, 1.20 ohms DC res max; sim to Jeffers $4421-9K.$
C4208	19A116655 P 8	Coramic disc: 150 pf ±10%, 1000 VDCW;	L207H	7488079P18	Choke, RF: 15.0 μh ±10%, 1.20 ohms DC rcs max; sim to Jeffers 4421-9K.
and C4210 C4211	1041144655500	sim to RMC Type JF Discap.	L208	19B219457P3	Coil.
24211	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L209	7488079P40	Choke, RF: 5.60 µh ±10%, 0.15 ohms DC res max; sim to Jeffers 4422-1.
24212L	19A116655P18	Ceramic disc: 680 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L210LL	7488079P18	Choke, RF: 15.0 μ h ±10%, 1.20 ohms DC res max; sim to Jeffers 4421-9K.
24212LL	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L210L	7488079940	Choke, RF: 5.60 μ h ±10%, 0.15 ohms DC res max; sim to Jeffers 4422-1K.
C4212M	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L210M	7488079918	Choke, RF: 15.0 µh ±10%, 1.20 ohms DC res max; sim to Jeffers 4421-9K.
C4212H	19A116655P18	Coramic disc: 680 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	L210H	7488079218	Choke, RF: 15.0 µh ±10%, 1.20 ohms DC res max; sim to Jeffers 4421-9K.

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
L211	19B219457P3	Co11.			
L213	19A129346G1	Coil.	R215	3R152P510J	Composition: 51 ohms ±5%, 1/4 w.
L214	19B219457P3	Coil,	R216	3R152P200J	Composition: 20 ohms $\pm 5\%$, $1/4$ w.
L215LL	7488079P18	Choke, RF: 15.0 µh ±10%, 1.20 ohms DC res max;	R217	3R77P470J	Composition: 47 ohms $\pm 5\%$, $1/2$ w.
		sim to Jeffers 4421-9.	R218	3R152P153J	Composition: 15,000 ohms $\pm 5\%$, 1/4 w.
L215L	7488079₽40	Choke, RF: 5.60 µh ±10%, 0.15 ohms DC res max; sim to Jeffers 4422-1.	R219	3R152P682J	Composition: 6800 ohms $\pm 5\%$, 1/4 w.
L215M	7488079P18	Choke, RF: 15.0 μb ±10%, 1.20 ohms DC res max; sim to Jeffers 4421-9.	R220 and R221	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
L215H	7488079P18	Choke, RF: 15.0 μh ±10%, 1.20 ohms DC res max; sim to Jeffers 4421-9.	R222	19A116278P253	Metal film: 3480 ohms $\pm 2\%$, 1/2 w.
L216	19B219457P3	Coil.	R223.	19A116278P201	Metal film: 1000 chms ±2%, 1/2 w.
L217	19A129346G1	Coil.	R224 and	19A116278P261	Metal film: 4220 ohms $\pm 2\%$, $1/2$ w.
L218LL	7488079P18	Choke, RF: 15.0 µh ±10%, 1.20 ohms DC res max; sim to Jeffers 4421-9.	R225 R226	19A116559P102	Variable, cermet: 5000 ohms $\pm 20\%$, .5 w; sim to
L218L	7488079 P 40	Choke, RF: 5.60 µh ±10%, 0.15 ohms DC res max; sim to Jeffers 4422-1.	R227	3R77P121J	CTS Seriés 360. Composition: 120 ohms ±5%, 1/2 w.
L218M	7488079P18	Choke, RF: 15.0 µh ±10%, 1.20 ohms DC res max;	R228	3R77P471J	Composition: 470 ohms ±5%, 1/2 w.
		sim to Jeffers 4421-9.	R229	3R152P182J	Composition: 1800 ohms $\pm 5\%$, 1/4 w.
L218H	7488079P18	Choke, RF: 15.0 μ h ±10%, 1.20 ohms DC res max; sim to Jeffers 4421-9.	R230	3R152P120J	Composition: 12 ohms ±5%, 1/4 w.
L219	19A129774P1	Coil.	R231	19A116278P269	Metal film: 5110 ohms ±2%, 1/2 w.
L220	19A129773G1	Coil.	R232	3R152P682J	Composition: 6800 ohms ±5%, 1/4 w.
L221LL	19C320623P1	Coil.	R233	3R152p681J	Composition: 680 ohms $\pm 5\%$, $1/4$ w.
L221L	19C320623P2	Coil.	R234	3R77P561J	Composition: 560 chms $\pm 5\%$, 1/2 w.
L221M	19C320623P2	Coil.			
L221H	19C320623P2	Coil.			VOLTAGE REGULATORS
L222LL	19C320623P1	Coil.	VR201	4036887P1	Silicon, Zener.
L222L	19C320623P2	Coil.	VR202	4036887P5	Silicon, Zener.
L222M	19C320623P2	Coil.			CABLES
L222H	19C320623P2	Coil.	₩202	19A129571P1	Strap.
L223LL	19C320623P1	Coil.	W203	19821999521	Jumper.
L223L	19C320623P2	Coil.	W204	19B219995P2	Jumper.
L223M	19C320623P2	Coil.	W205	19821999523	Jumper,
L223H	19C320623P2	Coil.	₩206	198219986P1	Jumper.
L224LL	19C320623P1	Coil.	W207	19821999525	Jumper.
L224L	19C320623P2	Coil.	W208		(Part of printed wiring board 19D417162Pl for
L224M	19C320623P2	Coil.	thru W237		L, M. H and 19D417402P1 for LL).
L224H	19C320623P2	Coil.	₩238	19B219995P4	Jumper
Q207	19A116201P1	Silicon, NPN.	Z201	19B219649G3	Filter
Q208	19A115910P1	Silicon, NPN; sim to Type 2N3904.			
Q209 thru Q211	19A115768P1	Silicon, PNP; sim to Type 2N3702.			HEAT SINK ASSEMBLY 19821968865
2212	19A115910P1	Silicon, NPN; sim to Type 2N3904.			
Q213	19A115779 P 1	Silicon, PNP; sim to Type 2N3251.	C297 and	19A116708P1	Ceramic, feed-thru: 0.01 uf +125 -0%, 500 VDC)
		RESISTORS	C 29 8		sim to Érie Style 327.
R201	3R152P102J	Composition: 1000 ohms $\pm 5\%$, $1/4$ w.	C299	19A115680P10	Electrolytic: 200 µf +150% -10%, 18 VDCW; sim to Mallory Type TT.
R202	3R77P101J	Composition: 100 ohms $\pm 5\%$, $1/2$ w.			
R203	3R77P150J	Composition: 15 ohms ±5%, 1/2 w.			DIODES AND RECTIFIERS
R204	19B209022P131	Wirewound: 4.7 ohms $\pm 10\%$, 2 w; sim to IRC Type BWH.	CR295	19A116783P1	Silicon.
R205	3R152P102J	Composition: 1000 ohms $\pm 5\%$, $1/4$ w.			MISCELLANEOUS
R206	3R77P100J	Composition: 10 ohms $\pm 5\%$, 1/2 w.		19D416712P5	Insulation. (Located under component board),
and R207		· · · · · · · · · · · · · · · · · · ·		19B201074P320	Tap screw, Phillips POZIDRIV [®] : No. 6-32 x 1-1, (Used with Filter casting).
R209	3R78P101J	Composition: 100 ohms ±5%, 1 w.		5492178P2	Washer, spring tension, (Used with Q201-Q206).
R210	3R78P100J	Composition: 10 ohms ±5%, 1 w.		N207P15C6	Hexnut: No. 8-32, (Used with Q201-Q206),
and R211				19A129661P1	Insulator. (Located by L295, L296).
R212	3R78P101J	Composition: 100 chms ±5%, 1 w.		19A129434P1	Washer, (Used with C297, C298).
R213	19C320212P2	Shunt resistor.		198129454P1 198209502P1	Terminal, stud. (Used with C297, C298).
and 3214					
	1			1	1

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

- REV. A Power Amplifier Component Board 19D417166G3. To increase Power Output. Changed C258 and C262.
- REV. B To incorporate new capacitors. Changed C216, C245, C251 C257 and C266.
- REV. C To improve operation in cold temperatures and wide frequency spacing. Changed CR201.
- REV. A Power Amplifier Component Board 19D417166G1, 2, 4. To incorporate new capacitors. Changed C216, C245, C251, C257 and C266.
- REV. B To improve operation in cold temperatures and wide frequency spacing. Changed CR201.

ORDERING SERVICE PARTS

Each component appearing on the schematic diagram is identified by a symbol number, to simplify locating it in the parts list. Each component is listed by symbol number, followed by its description and GE Part Number.

Service Parts may be obtained from Authorized GE Communication Equipment Service Stations or through any GE Radio Communication Equipment Sales Office. When ordering a part, be sure to give:

- 1. GE Part Number of component
- 2. Description of part
- Model number of equipment
 Revision letter stamped on unit

These instructions do not purport to cover all details or variations in equipment nor to provide for every possible contingency to be met in connection with installation, operation or maintenance.

Should further information be desired, or should particular problems arise which are not covered sufficiently for the purchaser's purposes, contact the nearest Radio Communication Equipment Sales Office of the General Electric Company.